

Jaipur Engineering College & Research Centre, Jaipur



(5EE4-04) Microprocessor

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Vision of JECRC

To become a renowned centre of outcome based learning, and work towards academic, professional, cultural and social enrichment of the lives of individuals and communities.

Mission of JECRC

- M1. Focus on evaluation of learning outcomes and motivate students to inculcate research aptitude by project based learning.
- M2. Identify, based on informed perception of Indian, regional and global needs, areas of focus and provide platform to gain knowledge and solutions.
- M3. Offer opportunities for interaction between academia and industry.
- M4. Develop human potential to its fullest extent so that intellectually capable and imaginatively gifted leaders can emerge in a range of professions.

Vision of EE Department

Electrical Engineering Department strives to be recognized globally for outcome based knowledge and to develop human potential to practice advance technology which contribute to society.

Mission of EE Department

- M1. To impart quality technical knowledge to the learners to make them globally competitive Electrical Engineers.
- M2. To provide the learners ethical guidelines along with excellent academic environment for a long productive career.
- M3. To promote industry-institute relationship.

PSO of EE Department

- PSO1 Graduates will be able to contribute for the development of automation.
- PSO2 Graduates will be able to contribute towards integration of the green energy.



PROGRAM OUTCOMES

1. **Engineering knowledge:** Apply the knowledge of mathematics, science, engineering fundamentals, and an engineering specialization to the solution of complex engineering problems.

2. **Problem analysis:** Identify, formulate, research literature, and analyze complex engineering problems reaching substantiated conclusions using first principles of mathematics, natural sciences, and engineering sciences.

3. **Design/development of solutions:** Design solutions for complex engineering problems and design system components or processes that meet the specified needs with appropriate consideration for the public health and safety, and the cultural, societal, and environmental considerations.

4. **Conduct investigations of complex problems:** Use research-based knowledge and research methods including design of experiments, analysis and interpretation of data, and synthesis of the information to provide valid conclusions.

5. **Modern tool usage:** Create, select, and apply appropriate techniques, resources, and modern engineering and IT tools including prediction and modeling to complex engineering activities with an understanding of the limitations.

6. **The engineer and society:** Apply reasoning informed by the contextual knowledge to assess societal, health, safety, legal and cultural issues and the consequent responsibilities relevant to the professional engineering practice.

7. Environment and sustainability: Understand the impact of the professional engineering solutions in societal and environmental contexts, and demonstrate the knowledge of, and need for sustainable development.

8. **Ethics:** Apply ethical principles and commit to professional ethics and responsibilities and norms of the engineering practice.

9. **Individual and team work**: Function effectively as an individual, and as a member or leader in diverse teams, and in multidisciplinary settings.

10. **Communication**: Communicate effectively on complex engineering activities with the engineering community and with society at large, such as, being able to comprehend and write effective reports and design documentation, make effective presentations, and give and receive clear instructions.

11. **Project management and finance**: Demonstrate knowledge and understanding of the engineering and management principles and apply these to one's own work, as



a member and leader in a team, to manage projects and in multidisciplinary environments.

12. **Life-long learning**: Recognize the need for, and have the preparation and ability to engage in independent and life-long learning in the broadest context of technological change.

Course Outcomes

CO1	To differentiate and analyse the properties features of Microprocessor and Microcontroller and understand the basic building blocks of a microcontroller
CO2	Identify a detail s/w and h/w structure of microcontrollers and programming techniques
CO3	Illustrate how the different peripheral and interfaced with microcontroller.

CO-PO Mapping

PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12	PSO1	PSO1
Co1	3	3	3	2	3	3	2	1	2	1	2	2	3	3
Co2	2	3	3	2	3	2	2	1	3	1	2	2	3	3
Co3	2	3	3	2	3	2	2	1	2	1	2	2	3	3



Teaching and Examination Scheme

S.NO	Course	Course		He	ours	5	Marks	5			Cr
	Туре				r						
				W	eek						
		Code	Name	L	Т	Р	Exa	IA	ETE	Total	
							m				
							Hrs				
1	PCC/PEC	5EE4-04	Microprocessor	3	0	0	3	30	120	150	3



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JAIPUR ENGINEERING COLLEGE AND RESEARCH CENTRE

RAJASTHAN TECHNICAL UNIVERSITY, KOTA

SYLLABUS 3rd Year - V Semester: B.Tech. (Electrical Engineering)

5EE4-04: MICROPROCESSOR

Credit: 3 3L+0T+0P Max. Marks: 150(IA:30, ETE:150)

End Term Exam: 3 Hours

Syllabus

SN	CONTENTS	HOURS
1	Introduction: Objective, scope and outcome of the course.	01
2	Fundamentals of Microprocessors Fundamentals of Microprocessor Architecture. 8-bitMicroprocessor and Microcontroller architecture, Comparison of 8-bit microcontrollers, 16-bit and 32-bit microcontrollers. Definition of embedded system and its characteris- tics, Role of microcontrollers in embedded Systems. Overview of the 8051 family.	07
3	The 8051 Architecture: Internal Block Diagram, CPU, ALU, address, data and control bus, Working registers, SFRs, Clock and RESET circuits, Stack and Stack Pointer, Program Counter, I/O ports, Memory Structures, Data and Program Memory, Timing diagrams and Execution Cycles.	08
4	Instruction Set and Programming Addressing modes: Introduction, Instruction syntax, Data types, Sub- routines Immediate addressing, Register addressing, Direct addressing, Indirect address- ing, Relative addressing, Indexed addressing, Bit inherent addressing, bit direct addressing. 8051 Instruction set, Instruction timings. Data transfer instructions, Arithmetic instruc- tions, Logical instructions, Branch instructions, Subroutine instructions, Bit manipulation in- struction. Assembly language programs, C language programs. Assemblers and compilers. Programming and debugging tools	08
5	Memory and I/O Interfacing Memory and I/O expansion buses, control signals, memory wait states. Interfacing of peripheral devices such as General Purpose I/O, ADC, DAC, timers, counters, memory devices.	06
6	External Communication Interface Synchronous and Asynchronous Communication. RS232, SPI, I2C. Introduction and interfacing to protocols like Blue-tooth and Zig-bee.	06
7	Applications LED, LCD and keyboard interfacing. Stepper motor interfacing, DC Motor interfacing, sensor interfacing	05
	TOTAL	41

UNIT - 1

1.1 MICROPROCESSORS AND MICROCONTROLLERS

Microprocessor				Microcontroller				
	Arithmetic ar unit	nd logic		ALU	Timer/ Counter	IO Ports		
	Accumulate Working Regi	or]	Accumulator Registers Internal RAM	Internal ROM	Interrupt Circuits		
Program	n Counter	Sta	ck Pointer	Stack Pointer		Clock		
Clock	Circuit	Inter	rrupt circuit		Program Counter			
Block diag	ram of micropr	ocessor		Block diagram o	of microcontroller			
Microprocessor contains ALU, General purpose registers, stack pointer, program counter, clock timing circuit, interrupt circuit			Microcontroller contains the circuitry of microprocessor, and in addition it has built in ROM, RAM, I/O Devices, Timers/Counters etc.					
It has many instructions to move data between memory and CPU			It has few instructions to move data between memory and CPU					
Few bit ha	ndling instruct	ion		It has many bit handling instructions				
Less numb	er of pins are r	nultifun	ctional	More number of pins are multifunctional				
Single me (program)	emory map	for da	ta and code	Separate memory map for data and code (program)				
Access time	e for memory a	and IO ar	re more	Less access time for built in memory and IO.				
Microprocessor based system requires additional hardware			It requires less additional hardwares					
More flexible in the design point of view				Less flexible since the additional circuits which is residing inside the microcontroller is fixed for a particular microcontroller				
Large nur addressing	nber of instr modes	ructions	with flexible	Limited number of instructions with few addressing modes				

1.2. RISC AND CISC CPU ARCHITECTURES

Microcontrollers with small instruction set are called reduced instruction set computer (RISC) machines and those with complex instruction set are called complex instruction set computer (CISC). Intel 8051 is an example of CISC machine whereas microchip PIC 18F87X is an example of RISC machine.

RISC	CISC			
Instruction takes one or two cycles	Instruction takes multiple cycles			
Only load/store instructions are used to access memory	In additions to load and store instructions, memory access is possible with other instructions also.			
Instructions executed by hardware	Instructions executed by the micro program			
Fixed format instruction	Variable format instructions			
Few addressing modes	Many addressing modes			
Few instructions	Complex instruction set			
Most of the have multiple register banks	Single register bank			
Highly pipelined	Less pipelined			
Complexity is in the compiler	Complexity in the microprogram			

Von-Neumann (Princeton architecture)	Harvard architecture			
CPU Data Program Memory Data Address Bus	CPU Address Bus Program Memory Address Bus Memory Address Bus			
Von-Neumann (Princeton architecture)	Harvard architecture			
It uses single memory space for both instructions and data.	It has separate program memory and data memory			
It is not possible to fetch instruction code and data	Instruction code and data can be fetched simultaneously			
Execution of instruction takes more machine cycle	Execution of instruction takes less machine cycle			
Uses CISC architecture	Uses RISC architecture			
Instruction pre-fetching is a main feature	Instruction parallelism is a main feature			
Also known as control flow or control driven computers	Also known as data flow or data driven computers			
Simplifies the chip design because of single memory space	Chip design is complex due to separate memory space			
Eg. 8085, 8086, MC6800	Eg. General purpose microcontrollers, special DSP chips etc.			

1.2. HARVARD & VON- NEUMANN CPU ARCHITECTURE

1.3 COMPUTER SOFTWARE

A set of instructions written in a specific sequence for the computer to solve a specific task is called a program and software is a collection of such programs.

The program stored in the computer memory in the form of binary numbers is called machine instructions. The *machine language* program is called *object code*.

An *assembly language* is a mnemonic representation of machine language. Machine language and assembly language are low level languages and are processor specific.

The assembly language program the programmer enters is called *source code*. The source code (assembly language) is translated to object code (machine language) using *assembler*.

Programs can be written in *high level languages* such as C, C++ etc. High level language will be converted to machine language using *compiler or interpreter*. Compiler reads the entire program and translate into the object code and then it is executed by the processor. Interpreter takes one statement of the high level language as input and translate it into object code and then executes.

1.4 THE 8051 ARCHITECTURE

Introduction

Salient features of 8051 microcontroller are given below.

- Eight bit CPU
- On chip clock oscillator
- 4Kbytes of internal program memory (code memory) [ROM]
- 128 bytes of internal data memory [RAM]
- 64 Kbytes of external program memory address space.
- 64 Kbytes of external data memory address space.
- 32 bi directional I/O lines (can be used as four 8 bit ports or 32 individually addressable I/O lines)
- Two 16 Bit Timer/Counter :T0, T1
- Full Duplex serial data receiver/transmitter
- Four Register banks with 8 registers in each bank.
- Sixteen bit Program counter (PC) and a data pointer (DPTR)
- 8 Bit Program Status Word (PSW)
- 8 Bit Stack Pointer
- Five vector interrupt structure (RESET not considered as an interrupt.)
- 8051 CPU consists of 8 bit ALU with associated registers like accumulator 'A', B register, PSW, SP, 16 bit program counter, stack pointer.
- ALU can perform arithmetic and logic functions on 8 bit variables.
- 8051 has 128 bytes of internal RAM which is divided into
 - Working registers [00 1F]
 - o Bit addressable memory area [20 2F]
 - o General purpose memory area (Scratch pad memory) [30-7F]

The 8051 architecture.



- 8051 has 4 K Bytes of internal ROM. The address space is from 0000 to 0FFFh. If the program size is more than 4 K Bytes 8051 will fetch the code automatically from external memory.
- Accumulator is an 8 bit register widely used for all arithmetic and logical operations. Accumulator is also used to transfer data between external memory. B register is used along with Accumulator for multiplication and division. A and B registers together is also called MATH registers.

 PSW (Program Status Word). This is an 8 bit register which contains the arithmetic status of ALU and the bank select bits of register banks.

CY A	C F0	RS1	RS0	OV	-	Р
------	------	-----	-----	----	---	---

CY	-	carry flag
AC	-	auxiliary carry flag
F0	-	available to the user for general purpose
RS1,F	RS0 -	register bank select bits
OV	-	overflow
Р	-	parity

- Stack Pointer (SP) it contains the address of the data item on the top of the stack. Stack
 may reside anywhere on the internal RAM. On reset, SP is initialized to 07 so that the default
 stack will start from address 08 onwards.
- Data Pointer (DPTR) DPH (Data pointer higher byte), DPL (Data pointer lower byte). This
 is a 16 bit register which is used to furnish address information for internal and external
 program memory and for external data memory.
- Program Counter (PC) 16 bit PC contains the address of next instruction to be executed. On reset PC will set to 0000. After fetching every instruction PC will increment by one.

1.5 PIN DIAGRAM



Pinout Description

Pins 1-8	PORT 1. Each of these pins can be configured as an input or an output.					
Pin 9	RESET . A logic one on this pin disables the microcontroller and clears the contents of most registers. In other words, the positive voltage on this pin resets the microcontroller. By applying logic zero to this pin, the program starts execution from the beginning.					
Pins10-17	PORT 3 . Similar to port 1, each of these pins can serve as general input or output. Besides, all of them have alternative functions					

Pin 10	RXD. Serial asynchronous communication input or Serial synchronous communication output.					
Pin 11	TXD. Serial asynchronous communication output or Serial synchronous communication clock output.					
Pin 12	INTO.External Interrupt 0 input					
Pin 13	INT1. External Interrupt 1 input					
Pin 14	T0. Counter 0 clock input					
Pin 15	T1. Counter 1 clock input					
Pin 16	WR. Write to external (additional) RAM					
Pin 17	RD. Read from external RAM					
Pin 18, 19	XTAL2, XTAL1. Internal oscillator input and output. A quartz crystal which specifies operating frequency is usually connected to these pins.					
Pin 20	GND. Ground.					
Pin 21-28	Port 2 . If there is no intention to use external memory then these port pins are configured as general inputs/outputs. In case external memory is used, the higher address byte, i.e. addresses A8-A15 will appear on this port. Even though memory with capacity of 64Kb is not used, which means that not all eight port bits are used for its addressing the rest of them are not available as inputs/outputs.					
Pin 29	PSEN. If external ROM is used for storing program then a logic zero (0) appears on it every time the microcontroller reads a byte from memory.					
Pin 30	ALE. Prior to reading from external memory, the microcontroller puts the lower address byte (A0-A7) on P0 and activates the ALE output. After receiving signal from the ALE pin, the external latch latches the state of P0 and uses it as a memory chip address. Immediately after that, the ALE pin is returned its previous logic state and P0 is now used as a Data Bus.					
Pin 31	EA . By applying logic zero to this pin, P2 and P3 are used for data and address transmission with no regard to whether there is internal memory or not. It means that even there is a program written to the microcontroller, it will not be executed. Instead, the program written to external ROM will be executed. By applying logic one to the EA pin, the microcontroller will use both memories, first internal then external (if exists).					
Pin 32-39	PORT 0 . Similar to P2, if external memory is not used, these pins can be used as general inputs/outputs. Otherwise, P0 is configured as address output (A0-A7) when the ALE pin is driven high (1) or as data output (Data Bus) when the ALE pin is driven low (0).					
Pin 40	VCC. +5V power supply.					

1.6 MEMORY ORGANIZATION

Internal RAM organization



Working Registers

Register Banks: 00h to 1Fh. The 8051 uses 8 general-purpose registers R0 through R7 (R0, R1, R2, R3, R4, R5, R6, and R7). There are four such register banks. Selection of register bank can be done through RS1,RS0 bits of PSW. On reset, the default Register Bank 0 will be selected.

Bit Addressable RAM: 20h to 2Fh. The 8051 supports a special feature which allows access to bit variables. This is where individual memory bits in Internal RAM can be set or cleared. In all there are 128 bits numbered 00h to 7Fh. Being bit variables any one variable can have a value 0 or 1. A bit variable can be set with a command such as SETB and cleared with a command such as CLR.

Example instructions are:

SETB 25h ; sets the bit 25h (becomes 1)

CLR 25h ; clears bit 25h (becomes 0)

Note, bit 25h is actually bit 5 of Internal RAM location 24h.

The Bit Addressable area of the RAM is just 16 bytes of Internal RAM located between 20h and 2Fh.

General Purpose RAM: 30h to 7Fh. Even if 80 bytes of Internal RAM memory are available for general-purpose data storage, user should take care while using the memory location from 00 -2Fh

since these locations are also the default register space, stack space, and bit addressable space. It is a good practice to use general purpose memory from 30 – 7Fh. The general purpose RAM can be accessed using direct or indirect addressing modes.

1.7 EXTERNAL MEMORY INTERFACING

Eg. Interfacing of 16 K Byte of RAM and 32 K Byte of EPROM to 8051

Number of address lines required for 16 Kbyte memory is 14 lines and that of 32Kbytes of memory is 15 lines.

PSEN PSEN A14 A14 A13 A13 A13 A12 A12 A12 32 Kbyte Λ9 A8 RAM A8 WR WE 16 Kbyte OE RD RAM A3 Δ7 AL LE Λ2 ۸1 A0-A7 8051 A0-A7 A1 Δ0 40 LOWER BYTE EA ADDRESS GND IAD - AD7 DAT DAT A A O/P O/P AD0 DATA BUS [AD0 - AD7] AD7

The connections of external memory is shown below.

The lower order address and data bus are multiplexed. De-multiplexing is done by the latch. Initially the address will appear in the bus and this latched at the output of latch using ALE signal. The output of the latch is directly connected to the lower byte address lines of the memory. Later data will be available in this bus. Still the latch output is address it self. The higher byte of address bus is directly connected to the memory. The number of lines connected depends on the memory size.

The RD and WR (both active low) signals are connected to RAM for reading and writing the data.

PSEN of microcontroller is connected to the output enable of the ROM to read the data from the memory.

EA (active low) pin is always grounded if we use only external memory. Otherwise, once the program size exceeds internal memory the microcontroller will automatically switch to external memory.

1.8 STACK

A stack is a last in first out memory. In 8051 internal RAM space can be used as stack. The address of the stack is contained in a register called stack pointer. Instructions PUSH and POP are used for stack operations. When a data is to be placed on the stack, the stack pointer increments before storing the data on the stack so that the stack grows up as data is stored (pre-increment). As the data is retrieved from the stack the byte is read from the stack, and then SP decrements to point the next available byte of stored data (post decrement). The stack pointer is set to 07 when the 8051 resets. So that default stack memory starts from address location 08 onwards (to avoid overwriting the default register bank ie., bank 0).

Eg; Show the stack and SP for the following.

	[SP]=07	//CONTENT OF SP IS 07 (DEFAULT VALUE)			
MOV R6, #25H	[R6]=25H	//CONTENT OF R6 IS 25	Н			
MOV R1, #12H	[R1]=12H	//CONTENT OF R1 IS 12H				
MOV R4, #0F3H	[R4]=F3H	//CONTENT OF R4 IS F3H				
PUSH 6	[SP]=08	[08]=[06]=25H	//CONTENT OF 08 IS 25H			
PUSH 1	[SP]=09	[09]=[01]=12H	//CONTENT OF 09 IS 12H			
PUSH 4	[SP]=0A	[0A]=[04]=F3H	//CONTENT OF 0A IS F3H			
505 /						
POP 6	[06]=[0A]=F3H	[SP]=09 //CON	FENT OF 06 IS F3H			
POP 1	[01]=[09]=12H	[SP]=08 //CON1	FENT OF 01 IS 12H			
POP 4	[04]=[08]=25H	[SP]=07 //CON1	FENT OF 04 IS 25H			

UNIT 2

2.1 INSTRUCTION SYNTAX.

General syntax for 8051 assembly language is as follows.

LABEL: OPCODE OPERAND ;COMMENT

LABEL : (*THIS IS NOT NECESSARY UNLESS THAT SPECIFIC LINE HAS TO BE ADDRESSED*). The label is a symbolic address for the instruction. When the program is assembled, the label will be given specific address in which that instruction is stored. Unless that specific line of instruction is needed by a branching instruction in the program, it is not necessary to label that line.

OPCODE: Opcode is the symbolic representation of the operation. The assembler converts the opcode to a unique binary code (machine language).

OPERAND: While opcode specifies what operation to perform, operand specifies where to perform that action. The operand field generally contains the source and destination of the data. In some cases only source or destination will be available instead of both. The operand will be either address of the data, or data itself.

COMMENT: Always comment will begin with ; *or* // symbol. To improve the program quality, programmer may always use comments in the program.

2.2 ADDRESSING MODES

Various methods of accessing the data are called addressing modes.

8051 addressing modes are classified as follows.

- 1. Immediate addressing.
- 2. Register addressing.
- 3. Direct addressing.
- 4. Indirect addressing.
- Relative addressing.
- 6. Absolute addressing.
- 7. Long addressing.
- 8. Indexed addressing.
- 9. Bit inherent addressing.
- 10. Bit direct addressing.

1. Immediate addressing.

In this addressing mode the data is provided as a part of instruction itself. In other words data immediately follows the instruction.

- Eg. MOV A,#30H
 - ADD A, #83

Symbol indicates the data is immediate.

2. Register addressing.

In this addressing mode the register will hold the data. One of the eight general registers (R0 to R7) can be used and specified as the operand.

Eg. MOV A,R0

ADD A,R6

R0 - R7 will be selected from the current selection of register bank. The default register bank will be bank 0.

3. Direct addressing

There are two ways to access the internal memory. Using direct address and indirect address. Using direct addressing mode we can not only address the internal memory but SFRs also. In direct addressing, an 8 bit internal data memory address is specified as part of the instruction and hence, it can specify the address only in the range of 00H to FFH. In this addressing mode, data is obtained directly from the memory.

Eg. MOV A,60h

ADD A,30h

4. Indirect addressing

The indirect addressing mode uses a register to hold the actual address that will be used in data movement. Registers R0 and R1 and DPTR are the only registers that can be used as data pointers. Indirect addressing cannot be used to refer to SFR registers. Both R0 and R1 can hold 8 bit address and DPTR can hold 16 bit address.

Eg. MOV A,@R0 ADD A,@R1 MOVX A,@DPTR

5. Indexed addressing.

In indexed addressing, either the program counter (PC), or the data pointer (DTPR)—is used to hold the base address, and the A is used to hold the offset address. Adding the value of the base address to the value of the offset address forms the effective address. Indexed addressing is used with JMP or MOVC instructions. Look up tables are easily implemented with the help of index addressing.

Eg. MOVC A, @A+DPTR // copies the contents of memory location pointed by the sum of the accumulator A and the DPTR into accumulator A.

MOVC A, @A+PC // copies the contents of memory location pointed by the sum of the accumulator A and the program counter into accumulator A.

6. Relative Addressing.

Relative addressing is used only with conditional jump instructions. The relative address, (offset), is an 8 bit signed number, which is automatically added to the PC to make the address of the next instruction. The 8 bit signed offset value gives an address range of +127 to —128 locations. The jump destination is usually specified using a label and the assembler calculates the jump offset accordingly. The advantage of relative addressing is that the program code is easy to relocate and the address is relative to position in the memory.

SJMP LOOP1

JC BACK

7. Absolute addressing

Eg.

Absolute addressing is used only by the AJMP (Absolute Jump) and ACALL (Absolute Call) instructions. These are 2 bytes instructions. The absolute addressing mode specifies the lowest 11 bit of the memory address as part of the instruction. The upper 5 bit of the destination address are

the upper 5 bit of the current program counter. Hence, absolute addressing allows branching only within the current 2 Kbyte page of the program memory.

Eg. AJMP LOOP1 ACALL LOOP2

8. Long Addressing

The long addressing mode is used with the instructions LJMP and LCALL. These are 3 byte instructions. The address specifies a full 16 bit destination address so that a jump or a call can be made to a location within a 64 Kbyte code memory space.

Eg. LJMP FINISH LCALL DELAY

9. Bit Inherent Addressing

In this addressing, the address of the flag which contains the operand, is implied in the opcode of the instruction.

Eg. CLR C ; Clears the carry flag to 0

10. Bit Direct Addressing

In this addressing mode the direct address of the bit is specified in the instruction. The RAM space 20H to 2FH and most of the special function registers are bit addressable. Bit address values are between 00H to 7FH.

Eg. CLR 07h ; Clears the bit 7 of 20h RAM space SETB 07H ; Sets the bit 7 of 20H RAM space.

2.3 INSTRUCTION SET.

1. Instruction Timings

The 8051 internal operations and external read/write operations are controlled by the oscillator clock.

T-state, Machine cycle and Instruction cycle are terms used in instruction timings.

T-state is defined as one subdivision of the operation performed in one clock period. The terms 'T-state' and 'clock period' are often used synonymously.

Machine cycle is defined as 12 oscillator periods. A machine cycle consists of six states and each state lasts for two oscillator periods. An instruction takes one to four machine cycles to execute an instruction. *Instruction cycle* is defined as the time required for completing the execution of an instruction. The 8051 instruction cycle consists of one to four machine cycles.

Eg. If 8051 microcontroller is operated with 12 MHz oscillator, find the execution time for the following four instructions.

- 1. ADD A, 45H
- 2. SUBB A, #55H
- 3. MOV DPTR, #2000H
- 4. MUL AB

Since the oscillator frequency is 12 MHz, the clock period is, Clock period = 1/12 MHz = $0.08333 \mu S$. Time for 1 machine cycle = $0.08333 \mu S \times 12 = 1 \mu S$.

1	Instruction	No. of machine cycles		Execution time
1.	ADD A, 45H	1	1 µs	

2.	SUBB A, #55H	2	2 μs
З.	MOV DPTR, #2000H	2	2 µs
4.	MUL AB	4	4 μs

2. 8051 Instructions

The instructions of 8051 can be broadly classified under the following headings.

- 1. Data transfer instructions
- 2. Arithmetic instructions
- 3. Logical instructions
- 4. Branch instructions
- 5. Subroutine instructions
- 6. Bit manipulation instructions

Data transfer instructions.

In this group, the instructions perform data transfer operations of the following types.

- a. Move the contents of a register Rn to A
 - i. MOV A,R2
 - ii. MOV A,R7
- b. Move the contents of a register A to Rn
 - i. MOV R4,A
 - ii. MOV R1,A
- Move an immediate 8 bit data to register A or to Rn or to a memory location(direct or indirect)
 - i.
 MOV A, #45H
 iv.
 MOV @R0, #0E8H

 ii.
 MOV R6, #51H
 v.
 MOV DPTR, #0F5A2H
 - iii. MOV 30H, #44H vi. MOV DPTR, #5467H
- *d.* Move the contents of a memory location to A or A to a memory location using direct and indirect addressing

i.	MOV A, 65H	iii.	MOV 45H, A
ü.	MOV A, @R0	iv.	MOV @R1, A

e. Move the contents of a memory location to Rn or Rn to a memory location using direct

addressing

- i. MOV R3, 65H
- ii. MOV 45H, R2
- f. Move the contents of memory location to another memory location using direct and indirect addressing
 - i. MOV 47H, 65H
 - ii. MOV 45H, @R0
- g. Move the contents of an external memory to A or A to an external memory
 - i. MOVX A,@R1 iii. MOVX A,@DPTR
 - iv. MOVX@DPTR,A
- h. Move the contents of program memory to A
 - i. MOVC A, @A+PC

ii. MOVX @R0.A

ii. MOVC A, @A+DPTR



FIG. Addressing Using MOV, MOVX and MOVC

i. Push and Pop instructions

	[SP]=07	//CONTENT OF	SP IS 07 (DEFAULT VALUE)
MOV R6, #25H	[R6]=25H	//CONTENT OF	7 R6 IS 25H
MOV R1, #12H	[R1]=12H	//CONTENT OF	R1 IS 12H
MOV R4, #0F3H	[R4]=F3H	//CONTENT OF	R4 IS F3H
PUSH 6	[SP]=08	[08]=[06]=25H	//CONTENT OF 08 IS 25H
PUSH 1	[SP]=09	[09]=[01]=12H	//CONTENT OF 09 IS 12H
PUSH 4	[SP]=0A	[0A]=[04]=F3H	//CONTENT OF 0A IS F3H
POP 6	[06]=[0A]=F3H	[SP]=09	//CONTENT OF 06 IS F3H
POP 1	[01]=[09]=12H	[SP]=08	//CONTENT OF 01 IS 12H
POP 4	[04]=[08]=25H	[SP]=07	//CONTENT OF 04 IS 25H

j. Exchange instructions

The content of source ie., register, direct memory or indirect memory will be exchanged with the contents of destination ie., accumulator.

- i. XCH A,R3
- ii. XCH A,@R1
- iii. XCH A,54h
- k. Exchange digit. Exchange the lower order nibble of Accumulator (A0-A3) with lower order nibble of the internal RAM location which is indirectly addressed by the register.
 - i. XCHD A,@R1
 - ii. XCHD A,@R0

Arithmetic instructions.

The 8051 can perform addition, subtraction. Multiplication and division operations on 8 bit numbers.

Addition

In this group, we have instructions to

- i. Add the contents of A with immediate data with or without carry.
 - i. ADD A, #45H
 - ii. ADDC A, #OB4H
- ii. Add the contents of A with register Rn with or without carry.
 - i. ADD A, R5
 - ii. ADDC A, R2
- iii. Add the contents of A with contents of memory with or without carry using direct and indirect addressing
 - i. ADD A, 51H
 - ii. ADDC A, 75H
 - iii. ADD A, @R1
 - iv. ADDC A, @R0

CY AC and OV flags will be affected by this operation.

Subtraction

In this group, we have instructions to

- i. Subtract the contents of A with immediate data with or without carry.
 - i. SUBB A, #45H
 - ii. SUBB A, #OB4H
- ii. Subtract the contents of A with register Rn with or without carry.
 - i. SUBB A, R5
 - ii. SUBB A, R2
- iii. Subtract the contents of A with contents of memory with or without carry using direct and indirect addressing
 - i. SUBB A, 51H
 - ii. SUBB A, 75H
 - iii. SUBB A, @R1
 - iv. SUBB A, @R0

CY AC and OV flags will be affected by this operation.

Multiplication

MUL AB. This instruction multiplies two 8 bit unsigned numbers which are stored in A and B register. After multiplication the lower byte of the result will be stored in accumulator and higher byte of result will be stored in B register.

Eg.	MOV A,#45H	;[A]=45H
-	MOV B,#0F5H	;[B]=F5H
	MUL AB	$[A] \times [B] = 45 \times F5 = 4209$
		;[A]=09H, [B]=42H

Division

DIV AB. This instruction divides the 8 bit unsigned number which is stored in A by the 8 bit unsigned number which is stored in B register. After division the result will be stored in accumulator and remainder will be stored in B register.

Eg. MOV A,#45H ;[A]=0E8H MOV B,#0F5H ;[B]=1BH DIV AB ;[A] / [B] = E8 /1B = 08 H with remainder 10H ;[A] = 08H, [B]=10H

DA A (Decimal Adjust After Addition).

When two BCD numbers are added, the answer is a non-BCD number. To get the result in BCD, we use DA A instruction after the addition. DA A works as follows.

- If lower nibble is greater than 9 or auxiliary carry is 1, 6 is added to lower nibble.
- If upper nibble is greater than 9 or carry is 1, 6 is added to upper nibble.

Eg 1:	MOV A,#23H MOV R1,#55H ADD A,R1 DA A	// [A]=78 // [A]=78	no changes in the accumulator after da a
Eg 2:	MOV A,#53H MOV R1,#58H ADD A,R1 DA A	// [A]=ABh // [A]=11, C=1	. ANSWER IS 111. Accumulator data is changed after DA A

Increment: increments the operand by one.

INC A	INC Rn	INC DIRECT	INC @RiINC DPTR
III C II	Internet internet	Inc Direct	nic ennic bi in

INC increments the value of source by 1. If the initial value of register is FFh, incrementing the value will cause it to reset to 0. The Carry Flag is not set when the value "rolls over" from 255 to 0.

In the case of "INC DPTR", the value two-byte unsigned integer value of DPTR is incremented. If the initial value of DPTR is FFFFh, incrementing the value will cause it to reset to 0.

Decrement: decrements the operand by one.

DEC A DEC Rn DEC DIRECT DEC @Ri

DEC decrements the value of *source* by 1. If the initial value of is 0, decrementing the value will cause it to reset to FFh. The Carry Flag is not set when the value "rolls over" from 0 to FFh.

Logical Instructions

Logical AND

ANL destination, source: ANL does a bitwise "AND" operation between *source* and *destination*, leaving the resulting value in *destination*. The value in source is not affected. "AND" instruction logically AND the bits of source and destination. ANL A,#DATA ANL A, Rn ANL A,DIRECT ANL A,@Ri ANL DIRECT, A ANL DIRECT, #DATA

Logical OR

ORL destination, source: ORL does a bitwise "OR" operation between source and destination,

leaving the resulting value in *destination*. The value in source is not affected. " OR " instruction logically OR the bits of source and destination. ORL A,#DATA ORL A, Rn ORL A,DIRECT ORL A,@Ri ORL DIRECT,A ORL DIRECT, #DATA

Logical Ex-OR

XRL destination, source: XRL does a bitwise "EX-OR" operation between *source* and *destination*, leaving the resulting value in *destination*. The value in source is not affected. "XRL " instruction logically EX-OR the bits of source and destination. XRL A,#DATA XRL A,Rn XRL A,DIRECT XRL A,@Ri XRL DIRECT,A XRL DIRECT, #DATA

Logical NOT

CPL complements *operand*, leaving the result in *operand*. If *operand* is a single bit then the state of the bit will be reversed. If *operand* is the Accumulator then all the bits in the Accumulator will be reversed.

CPL A, CPL C, CPL bit address

SWAP A - Swap the upper nibble and lower nibble of A.

Rotate Instructions

RR A

This instruction is rotate right the accumulator. Its operation is illustrated below. Each bit is shifted one location to the right, with bit 0 going to bit 7.

RL A

Rotate left the accumulator. Each bit is shifted one location to the left, with bit 7 going to bit 0

RRC A

Rotate right through the carry. Each bit is shifted one location to the right, with bit 0 going into the carry bit in the PSW, while the carry was at goes into bit 7

RLC A

Rotate left through the carry. Each bit is shifted one location to the left, with bit 7 going into the carry bit in the PSW, while the carry goes into bit 0.

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Branch (JUMP) Instructions

Jump and Call Program Range

There are 3 types of jump instructions. They are:-

- 1. Relative Jump
- 2. Short Absolute Jump
- 3. Long Absolute Jump

Relative Jump

Jump that replaces the PC (program counter) content with a new address that is greater than (the address following the jump instruction by 127 or less) or less than (the address following the jump by 128 or less) is called a relative jump. Schematically, the relative jump can be shown as follows: -



The advantages of the relative jump are as follows:-

- Only 1 byte of jump address needs to be specified in the 2's complement form, ie. For jumping ahead, the range is 0 to 127 and for jumping back, the range is -1 to -128.
- Specifying only one byte reduces the size of the instruction and speeds up program execution.
- The program with relative jumps can be relocated without reassembling to generate absolute jump addresses.

Disadvantages of the absolute jump: -

1. Short jump range (-128 to 127 from the instruction following the jump instruction)

Instructions that use Relative Jump

SJMP <relative address>; this is unconditional jump

The remaining relative jumps are conditional jumps

JC <relative address> JNC <relative address> JB bit, <relative address> JNB bit, <relative address> JBC bit, <relative address> CJNE <destination byte>, <source byte>, <relative address> DJNZ <byte>, <relative address> JZ <relative address> JNZ <relative address>

Short Absolute Jump

In this case only 11bits of the absolute jump address are needed. The absolute jump address is calculated in the following manner.

In 8051, 64 kbyte of program memory space is divided into 32 pages of 2 kbyte each. The hexadecimal addresses of the pages are given as follows:-

Page (Hex)	Address (Hex)
00	0000 - 07FF
01	0800 - 0FFF
02	1000 - 17FF
03	1800 - 1FFF
	P000 0700
1E	F000 - F7FF
1F	F800 - FFFF

It can be seen that the upper 5bits of the program counter (PC) hold the page number and the lower 11bits of the PC hold the address within that page. Thus, an absolute address is formed by taking page numbers of the instruction (from the program counter) following the jump and attaching the specified 11bits to it to form the 16-bit address.

Advantage: The instruction length becomes 2 bytes.

```
Example of short absolute jump: -
ACALL <address 11>
AJMP <address 11>
```

Long Absolute Jump/Call

Applications that need to access the entire program memory from 0000H to FFFFH use long absolute jump. Since the absolute address has to be specified in the op-code, the instruction length is 3 bytes (except for JMP @ A+DPTR). This jump is not re-locatable.

Example: -

LCALL <address 16> LJMP <address 16> JMP @A+DPTR

Another classification of jump instructions is

- 1. Unconditional Jump
- 2. Conditional Jump

- 1. The unconditional jump is a jump in which control is transferred unconditionally to the target location.
 - a. LJMP (long jump). This is a 3-byte instruction. First byte is the op-code and second and third bytes represent the 16-bit target address which is any memory location from 0000 to FFFFH eg: LJMP 3000H
 - AJMP: this causes unconditional branch to the indicated address, by loading the 11 bit address to 0 -10 bits of the program counter. The destination must be therefore within the same 2K blocks.
 - c. SJMP (short jump). This is a 2-byte instruction. First byte is the op-code and second byte is the relative target address, 00 to FFH (forward +127 and backward -128 bytes from the current PC value). To calculate the target address of a short jump, the second byte is added to the PC value which is address of the instruction immediately below the jump.

2. Conditional Jump instructions.

JBC	Jump if bit $= 1$ and clear bit
JNB	Jump if bit $= 0$
JB	Jump if bit $= 1$
JNC	Jump if $CY = 0$
JC	Jump if $CY = 1$
CJNE reg,#dat	a Jump if byte ≠ #data
CJNE A, byte	Jump if A ≠ byte
DJNZ	Decrement and Jump if $A \neq 0$
JNZ	Jump if A ≠ 0
JZ	Jump if $A = 0$

All conditional jumps are short jumps.

Bit level jump instructions:

Bit level JUMP instructions will check the conditions of the bit and if condition is true, it jumps to the address specified in the instruction. All the bit jumps are relative jumps.

JB bit, rel	; jump if the direct bit is set to the relative address specified.
JNB bit, rel	; jump if the direct bit is clear to the relative address specified.
JBC bit, rel	; jump if the direct bit is set to the relative address specified and then clear the bit.

Subroutine CALL And RETURN Instructions

Subroutines are handled by CALL and RET instructions

There are two types of CALL instructions

1. LCALL address(16 bit)

This is long call instruction which unconditionally calls the subroutine located at the indicated 16 bit address. This is a 3 byte instruction. The LCALL instruction works as follows.

- During execution of LCALL, [PC] = [PC]+3; (if address where LCALL resides is say, 0x3254; during execution of this instruction [PC] = 3254h + 3h = 3257h
- b. [SP]=[SP]+1; (if SP contains default value 07, then SP increments and [SP]=08
- c. [[SP]] = [PC₇₋₀]; (lower byte of PC content ie., 57 will be stored in memory location 08.
- d. [SP]=[SP]+1; (SP increments again and [SP]=09)
- e. [[SP]] = [PC₁₅₋₈]; (higher byte of PC content ie., 32 will be stored in memory location 09.

With these the address (0x3254) which was in PC is stored in stack.

f. [PC]= address (16 bit); the new address of subroutine is loaded to PC. No flags are affected.

2. ACALL address(11 bit)

This is absolute call instruction which unconditionally calls the subroutine located at the indicated 11 bit address. This is a 2 byte instruction. The SCALL instruction works as follows.

- During execution of SCALL, [PC] = [PC]+2; (if address where LCALL resides is say, 0x8549; during execution of this instruction [PC] = 8549h + 2h = 854Bh
- b. [SP]=[SP]+1; (if SP contains default value 07, then SP increments and [SP]=08
- c. [[SP]] = [PC₇₋₀]; (lower byte of PC content ie., 4B will be stored in memory location 08.
- d. [SP]=[SP]+1; (SP increments again and [SP]=09)
- e. [[SP]] = [PC15-8]; (higher byte of PC content ie., 85 will be stored in memory location 09.

With these the address (0x854B) which was in PC is stored in stack.

f. [PC₁₀₋₀]= address (11 bit); the new address of subroutine is loaded to PC. No flags are affected.

RET instruction

RET instruction pops top two contents from the stack and load it to PC.

- g. [PC15-8] = [[SP]] ;content of current top of the stack will be moved to higher byte of PC.
- h. [SP]=[SP]-1; (SP decrements)
- i. [PC7-0] = [[SP]] ;content of bottom of the stack will be moved to lower byte of PC.
- j. [SP]=[SP]-1; (SP decrements again)

Bit manipulation instructions.

8051 has 128 bit addressable memory. Bit addressable SFRs and bit addressable PORT pins. It is possible to perform following bit wise operations for these bit addressable locations.

- 1. LOGICAL AND
 - a. ANL C,BIT(BIT ADDRESS) ; 'LOGICALLY AND' CARRY AND CONTENT OF BIT ADDRESS, STORE RESULT IN CARRY
 - b. ANL C, /BIT; ; 'LOGICALLY AND' CARRY AND COMPLEMENT OF CONTENT OF BIT ADDRESS, STORE RESULT IN CARRY
- 2. LOGICAL OR
 - a. ORL C, BIT (BIT ADDRESS) ; 'LOGICALLY OR' CARRY AND CONTENT OF BIT ADDRESS, STORE RESULT IN CARRY
 - b. ORL C, /BIT; ; 'LOGICALLY OR' CARRY AND COMPLEMENT OF CONTENT OF BIT ADDRESS, STORE RESULT IN CARRY
- 3. CLR bit
 - a. CLR bit

a. CPL bit

b. CPL C

b. CLR C

- ; CONTENT OF BIT ADDRESS SPECIFIED WILL BE CLEARED.
- ; CONTENT OF CARRY WILL BE CLEARED.

4. CPL bit

- ; CONTENT OF BIT ADDRESS SPECIFIED WILL BE COMPLEMENTED.
- ; CONTENT OF CARRY WILL BE COMPLEMENTED.

UNIT 3

3.1 ASSEMBLER DIRECTIVES.

Assembler directives tell the assembler to do something other than creating the machine code for an instruction. In assembly language programming, the assembler directives instruct the assembler to

- 1. Process subsequent assembly language instructions
- 2. Define program constants
- 3. Reserve space for variables

The following are the widely used 8051 assembler directives.

ORG (origin)

The ORG directive is used to indicate the starting address. It can be used only when the program counter needs to be changed. The number that comes after ORG can be either in hex or in decimal. Eg: ORG 0000H :Set PC to 0000.

EQU and SET

EQU and SET directives assign numerical value or register name to the specified symbol name.

EQU is used to define a constant without storing information in the memory. The symbol defined with EQU should not be redefined.

SET directive allows redefinition of symbols at a later stage.

DB (DEFINE BYTE)

The DB directive is used to define an 8 bit data. DB directive initializes memory with 8 bit values. The numbers can be in decimal, binary, hex or in ASCII formats. For decimal, the 'D' after the decimal number is optional, but for binary and hexadecimal, 'B' and 'H' are required. For ASCII, the number is written in quotation marks ('LIKE This).

DATA1:	DB	40H	; hex
DATA2:	DB	01011100B	;binary
DATA3:	DB	48	; decimal
DATA4:	DB	'HELLOW'	; ASCII

END

The END directive signals the end of the assembly module. It indicates the end of the program to the assembler. Any text in the assembly file that appears after the END directive is ignored. If the END statement is missing, the assembler will generate an error message.

3.2 ASSEMBLY LANGUAGE PROGRAMS.

1. Write a program to add the values of locations 50H and 51H and store the result in locations in 52h and 53H.

ORG 0000H	; Set program counter 0000H		
MOV A,50H	; Load the contents of Memory location 50H into A ADD ADD A,51H		
; Add the contents of memory 51H with CONTENTS A			
MOV 52H,A	; Save the LS byte of the result in 52H		
MOV A, #00	; Load 00H into A		
ADDC A, #00	; Add the immediate data and carry to A		
MOV 53H,A	; Save the MS byte of the result in location 53h		
END			

2. Write a program to store data FFH into RAM memory locations 50H to 58H using direct addressing mode

ORG 0000H	; Set program counter 0000H
MOV A, #0FFH ; Load F	FH into A
MOV 50H, A	; Store contents of A in location 50H
MOV 51H, A	; Store contents of A in location 5IH
MOV 52H, A	; Store contents of A in location 52H
MOV 53H, A	; Store contents of A in location 53H
MOV 54H, A	; Store contents of A in location 54H
MOV 55H, A	; Store contents of A in location 55H
MOV 56H, A	; Store contents of A in location 56H
MOV 57H, A	; Store contents of A in location 57H
MOV 58H, A	; Store contents of A in location 58H
END	

3. Write a program to subtract a 16 bit number stored at locations 51H-52H from 55H-56H and store the result in locations 40H and 41H. Assume that the least significant byte of data or the result is stored in low address. If the result is positive, then store 00H, else store 01H in 42H.

ORG 0000H	; Set program counter 0000H
MOV A, 55H	; Load the contents of memory location 55 into A
CLR C	; Clear the borrow flag
SUBB A,51H	; Sub the contents of memory 51H from contents of A
MOV 40H, A	; Save the LSByte of the result in location 40H
MOV A, 56H	; Load the contents of memory location 56H into A
SUBB A, 52H	; Subtract the content of memory 52H from the content A
MOV 41H,	; Save the MSbyte of the result in location 415.
MOV A, #00	; Load 005 into A
ADDC A, #00	; Add the immediate data and the carry flag to A
MOV 42H, A	; If result is positive, store00H, else store 0lH in 42H
END	

4. Write a program to add two 16 bit numbers stored at locations 51H-52H and 55H-56H and store the result in locations 40H, 41H and 42H. Assume that the least significant byte of data and the result is stored in low address and the most significant byte of data or the result is stored in high address.

ORG 0000H	; Set program counter 0000H
MOV A,51H	; Load the contents of memory location 51H into A
ADD A,55H	; Add the contents of 55H with contents of A
MOV 40H,A	; Save the LS byte of the result in location 40H
MOV A,52H	; Load the contents of 52H into A
ADDC A,56H	; Add the contents of 56H and CY flag with A
MOV 41H,A	; Save the second byte of the result in 41H
MOV A,#00	; Load 00H into A
ADDC A,#00	; Add the immediate data 00H and CY to A
MOV 42H,A	; Save the MS byte of the result in location 42H
END	

5. Write a program to store data FFH into RAM memory locations 50H to 58H using indirect addressing mode.

ORG 0000H	; Set program counter 0000H
MOV A, #0FFH	; Load FFH into A
MOV RO, #50H	; Load pointer, R0-50H
MOV R5, #08H	; Load counter, R5-08H
Start:MOV @RO, A	; Copy contents of A to RAM pointed by R0
INC RO	; Increment pointer
DJNZ R5, start ; Repea	t until R5 is zero
END	

6. Write a program to add two Binary Coded Decimal (BCD) numbers stored at locations 60H and 61H and store the result in BCD at memory locations 52H and 53H. Assume that the least significant byte of the result is stored in low address.

ORG 0000H	; Set program counter 00004
MOV A,60H	; Load the contents of memory location 6.0 H into A
ADD A,61H	; Add the contents of memory location 61H with contents of A
DA A	; Decimal adjustment of the sum in A
MOV 52H, A	; Save the least significant byte of the result in location 52H
MOV A,#00	; Load 00H into .A
ADDC A,#00H	; Add the immediate data and the contents of carry flag to A
MOV 53H,A	; Save the most significant byte of the result in location 53:,
END	

7. Write a program to clear 10 RAM locations starting at RAM address 1000H.

ORG 0000H ;Set program counter 0000H MOV DPTR, #1000H ;Copy address 1000H to DPTR CLR A ;Clear A MOV R6, #0AH ;Load 0AH to R6 again: MOVX @DPTR,A ;Clear RAM location pointed by DPTR

	INC DPTR	;Increment DPTR
	DJNZ R6, again END	;Loop until counter R6=0
R	Write a program to comp	ute $1 + 2 + 3 + N$ (say N=15) and save the sum at 70H
	ORG 0000H	: Set program counter 0000H
	N EOU 15	,
	MOV R0,#00	; Clear R0
	CLR A	; Clear A
	again: INC R0	; Increment R0
	ADD A, RO	; Add the contents of R0 with A
	CJNE R0,#N,aga	in ; Loop until counter, R0, N
	MOV 70H,A	; Save the result in location 70H END
).	Write a program to multip	ply two 8 bit numbers stored at locations 70H and 71H and store the
	result at memory location	s 52H and 53H. Assume that the least significant byte of the result is
	stored in low address.	
	ORG 0000H ; Set program c	ounter 00 OH
	MOV A, 70H ; Load the conte	ents of memory location 70h into A
	MOV B, 71H ; Load the conte	ents of memory location 71H into B
	MUL AB ; Perform m	ultiplication
	MOV 52H,A; Save the least si	gnificant byte of the result in location 52H MOV 53H,B ; Save the most
	significant byte of the result	in location 53
	END	
10.	Ten 8 bit numbers are s	stored in internal data memory from location 5oH. Write a
	program to increment th	ie data.
	Assume that ten 8 bit nu	mbers are stored in internal data memory from location 50H, hence
	R0 or R1 must be used as a p	oointer.
	The program is as follows.	
	OPT 0000H	
	MOV R0,#50H	
	MOV R3,#0AH	
	Loopl: INC @R0	
	INC RO	
	DJNZ R3, loopl END)
	END	
11.	Write a program to find	the average of five 8 bit numbers. Store the result in H.
	(Assume that after adding	ng five 8 bit numbers, the result is 8 bit only).
	ORG 0000H	
	MOV 40H,#05H	
	MOV 41H,#55H	
	MOV 42H,#06H	
	MOV 43H,#1AH	
	MOV 44H,#09H	
	MOV R0,#40H	
	MOV R5,#05H	
	CLR A	
	LOOP: ADD A @DO	
	LOOP: ADD A,@RO	
	INC RO	
		2

DJNZ R5,Loop DIV AB MOV 55H,A END 12. Write a program to find the cube of an 8 bit number program is as follows **ORG 0000H** MOV R1,#N MOV A,R1 MOV B,R1 MUL AB //SQUARE IS COMPUTED MOV R2, B MOV B, R1 MUL AB MOV 50,A MOV 51,B MOV A,R2 MOV B, R1 MUL AB ADD A, 51H MOV 51H, A MOV 52H, B MOV A, # 00H ADDC A, 52H //CUBE IS STORED IN 52H,51H,50H MOV 52H, A END

13. Write a program to exchange the lower nibble of data present in external memory 6000H and 6001H

ORG 0000H	; Set program counter 00h
MOV DPTR, #6000H	; Copy address 6000H to DPTR
MOVX A, @DPTR	; Copy contents of 60008 to A
MOV R0, #45H	; Load pointer, R0=45H
MOV @RO, A	; Copy cont of A to RAM pointed by 80
INC DPL	; Increment pointer
MOVX A, @DPTR	; Copy contents of 60018 to A
XCHD A, @R0	; Exchange lower nibble of A with RAM pointed by RO
MOVX @DPTR, A	; Copy contents of A to 60018
DEC DPL	; Decrement pointer
MOV A, @R0	; Copy cont of RAM pointed by R0 to A
MOVX @DPTR, A	; Copy cont of A to RAM pointed by DPTR
END	

14. Write a program to count the number of and o's of 8 bit data stored in location 6000H.

ORG 00008	; Set program counter 00008
MOV DPTR, #6000h	; Copy address 6000H to DPTR
MOVX A, @DPTR	; Copy number to A
MOV R0,#08	; Copy 08 in RO
MOV R2,#00	; Copy 00 in R2
MOV R3,#00	; Copy 00 in R3
CLR C	; Clear carry flag
BACK: RLC A	; Rotate A through carry flag

```
JC NEXT ; If CF = 1, branch to next
INC R2 ; If CF = 0, increment R2 AJMP NEXT2
NEXT: INC R3 ; If CF = 1, increment R3
NEXT2: DJNZ RO,BACK ; Repeat until RO is zero
END
```

15. Write a program to shift a 24 bit number stored at 57H-55H to the left logically four places. Assume that the least significant byte of data is stored in lower address.

```
ORG 0000H ; Set program counter 0000h
MOV R1,#04 ; Set up loop count to 4
again: MOV A,55H ; Place the least significant byte of data in A
                               ; Clear tne carry flag
                CLR C
                                ; Rotate contents of A (55h) left through carry
                RLC A
                MOV 55H,A
                MOV A,56H
                                ; Rotate contents of A (56H) left through carry
                RLC A
                MOV 56H,A
                MOV A,57H
                RLC A
                                ; Rotate contents of A (57H) left through carry
                MOV 57H,A
                DJNZ R1, again ; Repeat until R1 is zero
                END
```

16. Two 8 bit numbers are stored in location 1000h and 1001h of external data memory. Write a program to find the GCD of the numbers and store the result in 2000h. ALGORITHM

	•	Step 1	Initialize external data memory with data and DPTR with address:				
	•	Step 2	:Load A and TEMP with the operands				
	•	Step 3	:Are the two operands equal? If yes, go to step 9				
	•	Step 4	:Is (A) greater than	(TEMP) ? If yes, go to step 6			
	•	Step 5	:Exchange (A) with	(TEMP) such that A contains the bigger number			
	•	Step 6	:Perform division of	peration (contents of A with contents of TEMP)			
	•	Step 7	:If the remainder is	zero, go to step 9			
	•	Step 8	:Move the remainde	r into A and go to step 4			
	•	Step 9	:Save the contents 'o	of TEMP in memory and terminate the program			
		ORG 00	00H	; Set program counter 0000H			
		TEMP E	EQU 70H				
		TEMPI	EQU 71H				
		MOV D	PTR, #1000H	; Copy address 100011 to DPTR			
		MOVX /	A, @DPTR	; Copy First number to A			
		MOV TI	EMP, A	; Copy First number to temp INC DPTR			
		MOVX /	A, @DPTR	; Copy Second number to A			
LOOPS: CJN	ΕA,	TEMP, I	LOOP1 ; (A) /=	(TEMP) branch to LOOP1			
		AJMP L	00P2	; (A) = (TEMP) branch to L00P2			
LOOP1:		JNC LO	OP3	; (A) > (TEMP) branch to LOOP3			
		NOV TE	EMPI, A	; (A) < (TEMP) exchange (A) with (TEMP)			
		MOV A,	TEMP				
		MOV TI	ЕМР, ТЕМРІ				
LOOP3:		MOV B.	TEMP				
		DIV AB		: Divide (A) by (TEMP)			
		MOV A	B	: Move remainder to A			
		CINE A	#00 LOOPS	(A) = 00 branch to LOOPS			
LOOP2.		MOV A	TEMD	, (A)/=00 branch to LOOF 5			
L00F2:		MOV A,					
		MOV D	PTR, #2000H				
		MOVX (@DPTR, A	; Store the result in 2000H			
		END					

UNIT 5

5.1 BASICS OF INTERRUPTS.

During program execution if peripheral devices needs service from microcontroller, device will generate interrupt and gets the service from microcontroller. When peripheral device activate the interrupt signal, the processor branches to a program called interrupt service routine. After executing the interrupt service routine the processor returns to the main program.

Steps taken by processor while processing an interrupt:

- 1. It completes the execution of the current instruction.
- 2. PSW is pushed to stack.
- 3. PC content is pushed to stack.
- 4. Interrupt flag is reset.
- 5. PC is loaded with ISR address.

ISR will always ends with RETI instruction. The execution of RETI instruction results in the following.

- 1. POP the current stack top to the PC.
- 2. POP the current stack top to PSW.

Classification of interrupts.

1. External and internal interrupts.

External interrupts are those initiated by peripheral devices through the external pins of the microcontroller.

Internal interrupts are those activated by the internal peripherals of the microcontroller like timers, serial controller etc.)

2. Maskable and non-maskable interrupts.

The category of interrupts which can be disabled by the processor using program is called maskable interrupts.

Non-maskable interrupts are those category by which the programmer cannot disable it using program.

3. Vectored and non-vectored interrupt.

Starting address of the ISR is called interrupt vector. In vectored interrupts the starting address is predefined. In non-vectored interrupts, the starting address is provided by the peripheral as follows.

- Microcontroller receives an interrupt request from external device.
- Controller sends an acknowledgement (INTA) after completing the execution of current instruction.
- The peripheral device sends the interrupt vector to the microcontroller.

5.2 8051 INTERRUPT STRUCTURE.

8051 has five interrupts. They are maskable and vectored interrupts. Out of these five, two are external interrupt and three are internal interrupts.

Interrupt source	Туре	Vector address	Priority
External interrupt 0	External	0003	Highest
Timer 0 interrupt	Internal	000B	
External interrupt 1	External	0013	
Timer 1 interrupt	Internal	001B	
Serial interrupt	Internal	0023	Lowest

8051 makes use of two registers to deal with interrupts.

1. IE Register

This is an 8 bit register used for enabling or disabling the interrupts. The structure of IE register is shown below.

IE : Interrupt Enable Register (Bit Addressable)

If the bit is 0, the corresponding interrupt is disabled. If the bit is 1, the corresponding interrupt is enabled.

s i, die correspon	ang mene	pero enabre					
EA		_	ES	ETI	EX1	ET0	EX0

EA	IE.7	Disables all interrupts. If $EA = 0$, no interrupt will be acknowledged. If $EA = 1$, interrupt source is individually enable or disabled by setting or clearing its enable bit.
-	IE.6	Not implemented, reserved for future use*.
-	IE.5	Not implemented, reserved for future use*.
ES	IE.4	Enable or disable the Serial port interrupt.
ET1	IE.3	Enable or disable the Timer 1 overflow interrupt.
EX1	IE.2	Enable or disable External interrupt 1.
ET0	IE.1	Enable or disable the Timer 0 overflow interrupt.
EX0	IE.0	Enable or disable External Interrupt 0.

2. IP Register.

This is an 8 bit register used for setting the priority of the interrupts.

IP : Interrupt Priority Register (Bit Addressable)

If the bit is 0, the corresponding interrupt has a lower priority and if the bit is the corresponding interrupt has a higher priority.

	L	-	-	-	PS	PT1	PX1	PT0	PX0
- II	P.7	Not	implement	ed, reserved	d for future	use*.			
- II	P.6	Not	implement	ed, reserved	d for future	use*.			
- IF	P.5	Not	Not implemented, reserved for future use*.						
PS IF	P.4	Def	Defines the Serial Port interrupt priority level.						
PT1 IF	P.3	Def	ines the Tin	ner 1 Interr	upt priority	level.			
PX1 IF	P.2	Def	ines Extern	al Interrupt	priority le	vel.			
PT0 IF	P.1	Def	ines the Tin	ner 0 interre	upt priority	level.			
PX0 II	P.0	Def	ines the Ext	ternal Intern	rupt 0 prior	ity level.			

5.2 TIMERS AND COUNTERS

Timers/Counters are used generally for

- Time reference
- Creating delay
- Wave form properties measurement
- Periodic interrupt generation
- Waveform generation

8051 has two timers, Timer 0 and Timer 1.



Timer in 8051 is used as timer, counter and baud rate generator. Timer always counts up irrespective of whether it is used as timer, counter, or baud rate generator: Timer is always incremented by the microcontroller. The time taken to count one digit up is based on master clock frequency.

If Master CLK=12 MHz, Timer Clock frequency = Master CLK/12 = 1 MHz Timer Clock Period = 1micro second This indicates that one increment in count will take 1 micro second.

The two timers in 8051 share two SFRs (TMOD and TCON) which control the timers, and each timer also has two SFRs dedicated solely to itself (TH0/TL0 and TH1/TL1).

The following are timer related SFRs in 8051.

SFR Name	Description	SFR Address
ТНО	Timer 0 High Byte	8Ch
TLO	Timer 0 Low Byte	8Ah
TH1	Timer 1 High Byte	8Dh
TL1	Timer 1 Low Byte	8Bh
TCON	Timer Control	88h
TMOD	Timer Mode	89h

TMOD Register

TMOD : Timer/Counter Mode Control Register (Not Bit Addressable)

M1	M0		OPERATI	NG MODE					
Note 1 :									
M0	Mode selec	Mode selector bit (NOTE 1).							
M1	Mode selec	tor bit (NC	TE 1).						
C/T	Timer or C Counter op	Timer or Counter selector. Cleared for Timer operation (input from internal system clock). Set for Counter operation (input from Tx input pin).						clock). Set for	
GATE	When TRx (hardware control).	When TRx (in TCON) is set and GATE = 1, TIMER/COUNTERx will run only while INTx pin is high (hardware control). When GATE = 0, TIMER/COUNTERx will run only while TRx = 1 (software control).							
		TIM	ER 1		1	TIM	ER 0]
	GAIE	GATE C/I MI M0				0/1	MI	MO	-
	CATE	.c.₩	MI	MO	CATE	<u></u>	M	10	1

0	0	0	13-bit Timer
0	1	1	16-bit Timer/Counter
1	0	2	8-bit Auto-Reload Timer/Counter
1	1	3	(Timer 0) TL0 is an 8-bit Timer/Counter controlled by the standard Timer 0 control
			bits, TH0 is an 8-bit Timer and is controlled by Timer 1 control bits.
1	1	3	(Timer 1) Timer/Counter 1 stopped.

TCON Register

TCON : Timer/Counter Control Register (Bit Addressable)

		TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0	
TF1	тсо	N.7 Tin har	ner 1 overf dware as pro	low flag. S	Set by hard tors to the i	dware when	n the Time rvice routin	er/Counter e.	1 overflow	s. Cleared by
TR1	TCO	N.6 Tin	ner 1 run co	ntrol bit. Se	et/cleared by	y software t	to turn Tim	er/Counter	ON/OFF.	
TF0	TCO	N.5 Tin har	ner 0 overf dware as pro	low flag. S ocessor vec	Set by hard tors to the s	dware when service rout	n the Time ine.	er/Counter	0 overflow	s. Cleared by
TR0	TCO	N.4 Tin	ner 0 run co	ntrol bit. Se	et/cleared by	y software t	to turn Tim	er/Counter	0 ON/OFF.	
IE1	TCO	N.3 Ext by	ernal Interre hardware w	upt 1 edge f	flag. Set by pt is process	hardware w sed.	when Extern	al interrupt	edge is det	ected. Cleared
IT1	TCO	N.2 Inte Ext	errupt 1 type ernal Interre	e control bi upt.	it. Set/clear	ed by softw	vare to spec	cify falling	edge/flow l	evel triggered
IE0	TCO	N.1 Ext by	ernal Interr hardware w	upt 0 edge hen interru	flag. Set by pt is process	hardware sed.	when Exter	rnal Interru	pt edge dete	ected. Cleared
IT0	TCO	N.0 Inte Ext	errupt 0 typ ernal Interr	e control b upt.	it. Set/clear	red by softw	ware to spe	cify falling	edge/low l	evel triggered

Timer/ Counter Control Logic.



TIMER MODES

Timers can operate in four different modes. They are as follows *Timer Mode-0:* In this mode, the timer is used as a 13-bit UP counter as follows.



Fig. Operation of Timer on Mode-0

The lower 5 bits of TLX and 8 bits of THX are used for the 13 bit count.Upper 3 bits of TLX are ignored. When the counter rolls over from all 0's to all 1's, TFX flag is set and an interrupt is generated. The input pulse is obtained from the previous stage. If TR1/0 bit is 1 and Gate bit is 0, the counter continues counting up. If TR1/0 bit is 1 and Gate bit is 1, then the operation of the counter is controlled by input. This mode is useful to measure the width of a given pulse fed to input.

Timer Mode-1: This mode is similar to mode-0 except for the fact that the Timer operates in 16-bit mode.



Fig: Operation of Timer in Mode 1

Timer Mode-2: (Auto-Reload Mode): This is a 8 bit counter/timer operation. Counting is performed in TLX while THX stores a constant value. In this mode when the timer overflows i.e. TLX becomes FFH, it is fed with the value stored in THX. For example if we load THX with 50H then the

timer in mode 2 will count from 50H to FFH. After that 50H is again reloaded. This mode is useful in applications like fixed time sampling.





Timer Mode-3: Timer 1 in mode-3 simply holds its count. The effect is same as setting TR1=0. Timer0 in mode-3 establishes TL0 and TH0 as two separate counters.



Control bits TR1 and TF1 are used by Timer-0 (higher 8 bits) (TH0) in Mode-3 while TR0 and TF0 are available to Timer-0 lower 8 bits(TL0).

5.2 PROGRAMMING 8051 TIMERS IN ASSEMBLY

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In order to program 8051 timers, it is important to know the calculation of initial count value to be stored in the timer register. The calculations are as follows.

In any mode, Timer Clock period =

- 1/Timer Clock Frequency.
- 1/(Master Clock Frequency/12)
- a. Mode 1 (16 bit timer/counter)
 Value to be loaded in decimal = 65536 (Delay Required/Timer clock period)
 Convert the answer into hexadecimal and load onto THx and TLx register.
 (65536_D = FFFF_H+1)
- b. Mode 0 (13 bit timer/counter) Value to be loaded in decimal = 8192 – (Delay Required/Timer clock period) Convert the answer into hexadecimal and load onto THx and TLx register. (8192b = 1FFFH+1)
- c. Mode 2 (8 bit auto reload)
 Value to be loaded in decimal = 256 (Delay Required/Timer clock period)
 Convert the answer into hexadecimal and load onto THx register. Upon starting the timer this value from THx will be reloaded to TLx register.
 (256_D = FF_H+1)

Steps for programming timers in 8051

Mode 1:

- Load the TMOD value register indicating which timer (0 or 1) is to be used and which timer mode is selected.
- Load registers TL and TH with initial count values.
- Start the timer by the instruction "SETB TR0" for timer 0 and "SETB TR1" for timer 1.
- Keep monitoring the timer flag (TF) with the "JNB TFx,target" instruction to see if it is raised. Get out of the loop when TF becomes high.
- Stop the timer with the instructions "CLR TR0" or "CLR TR1", for timer 0 and timer 1, respectively.
- Clear the TF flag for the next round with the instruction "CLR TF0" or "CLR TF1", for timer 0 and timer 1, respectively.
- Go back to step 2 to load TH and TL again.

Mode 0:

The programming techniques mentioned here are also applicable to counter/timer mode 0. The only difference is in the number of bits of the initialization value.

Mode 2:

- Load the TMOD value register indicating which timer (0 or 1) is to be used; select timer mode 2.
- Load TH register with the initial count value. As it is an 8-bit timer, the valid range is from 00 to FFH.
- Start the timer.

- Keep monitoring the timer flag (TFx) with the "JNB TFx,target" instruction to see if it is raised. Get out of the loop when TFx goes high.
- Clear the TFx flag.
- Go back to step 4, since mode 2 is auto-reload.

1. Write a program to continuously generate a square wave of 2 kHz frequency on pin P1.5 using timer 1. Assume the crystal oscillator frequency to be 12 MHz.

The period of the square wave is T = $1/(2 \text{ kHz}) = 500 \text{ }\mu\text{s}$. Each half pulse = $250 \text{ }\mu\text{s}$. The value n for 250 μs is: 250 $\mu\text{s} / 1 \text{ }\mu\text{s} = 250$ 65536 - 250 = FF06H. TL = 06H and TH = 0FFH.

MOV	TMOD,#10	;Timer 1, mode 1
MOV	TL1,#06H	;TL0 = 06H
MOV	TH1,#0FFH	;THO = FFH
SETB	TR1	;Start timer 1
JNB	TF1,BACK	;Stay until timer rolls over
CLR	TR1	;Stop timer 1
CPL	P1.5	;Complement P1.5 to get Hi, Lo
CLR	TF1	;Clear timer flag 1
SJMP	AGAIN	;Reload timer
	MOV MOV SETB JNB CLR CPL CLR SJMP	MOV TMOD,#10 MOV TL1,#06H MOV TH1,#0FFH SETB TR1 JNB TF1,BACK CLR TR1 CPL P1.5 CLR TF1 SJMP AGAIN

2. Write a program segment that uses timer 1 in mode 2 to toggle P1.0 once whenever the counter reaches a count of 100. Assume the timer clock is taken from external

source P3.5 (T1).

The TMOD value is 60H The initialization value to be loaded into TH1 is 256 - 100 = 156 = 9CH

	MOV	TMOD,#	60h ;Counter1, mode 2, C/T'= 1
	MOV	TH1,#90	Ch ;Counting 100 pulses
	SETB	P3.5	;Make T1 input
	SETB	TR1	;Start timer 1
BACK: JNB	TF1,B	ACK ;I	Keep doing it if TF = 0
	CPL	P1.0	;Toggle port bit
	CLR	TF1	;Clear timer overflow flag
	SJMP	BACK	;Keep doing it

UNIT 6

6.1 SERIAL COMMUNICATION.

6.1.1. DATA COMMUNICATION

The 8051 microcontroller is parallel device that transfers eight bits of data simultaneously over eight data lines to parallel I/O devices. Parallel data transfer over a long is very expensive. Hence, a serial communication is widely used in long distance communication. In serial data communication, 8-bit data is converted to serial bits using a parallel in serial out shift register and then it is transmitted over a single data line. The data byte is always transmitted with least significant bit first.

6.1.2. BASICS OF SERIAL DATA COMMUNICATION,

Communication Links

1. Simplex communication link: In simplex transmission, the line is dedicated for transmission. The transmitter sends and the receiver receives the data.



2. Half duplex communication link: In half duplex, the communication link can be used for either transmission or

reception. Data is transmitted in only one direction at a time.



3. Full duplex communication link: If the data is transmitted in both ways at the same time, it is a full duplex i.e. transmission and reception can proceed simultaneously. This communication link requires two wires for data, one for transmission and one for reception.



Types of Serial communication:

Serial data communication uses two types of communication.

1. Synchronous serial data communication: In this transmitter and receiver are synchronized. It uses a common clock to synchronize the receiver and the transmitter. First the synch character is sent and then the data is transmitted. This format is generally used for high speed transmission. In Synchronous serial data communication a block of data is transmitted at a time.



Data

Clock

2. Asynchronous Serial data transmission: In this, different clock sources are used for transmitter and receiver. In this mode, data is transmitted with start and stop bits. A transmission begins with start bit, followed by data and then stop bit. For error checking purpose parity bit is included just prior to stop bit. In Asynchronous serial data communication a single byte is transmitted at a time.



Baud rate:

The rate at which the data is transmitted is called baud or transfer rate. The baud rate is the reciprocal of the time to send one bit. In asynchronous transmission, baud rate is not equal to number of bits per second. This is because; each byte is preceded by a start bit and followed by parity and stop bit. For example, in synchronous transmission, if data is transmitted with 9600 baud, it means that 9600 bits are transmitted in one second. For bit transmission time = 1 second/9600 = 0.104 ms.

6.1.3. 8051 SERIAL COMMUNICATION

The 8051 supports a full duplex serial port.

Three special function registers support serial communication.

- 1. SBUF Register: Serial Buffer (SBUF) register is an 8-bit register. It has separate SBUF registers for data transmission and for data reception. For a byte of data to be transferred via the TXD line, it must be placed in SBUF register. Similarly, SBUF holds the 8-bit data received by the RXD pin and read to accept the received data.
- SCON register: The contents of the Serial Control (SCON) register are shown below. This
 register contains mode selection bits, serial port interrupt bit (TI and RI) and also the ninth
 data bit for transmission and reception (TB8 and RB8).

Serial Port Control (SCON) Register							
D7	D6	D5	D4	D3	D2	D1	D0
SM0	SM1	SM2	REN	TB8	RB8	TI	RI

SM0 (SCON.7): Serial communication mode selection bit
 SM1 (SCON.6): Serial communication mode selection bit

SM0	SM1	Mode	Description	Baud rate
0	0	Mode 0	8-bit shift register mode	Fosc / 12
0	1	Mode 1	8-bit UART	Variable (set by timer 1)
1	0	Mode 2	9-bit UART	Fosc/ 32 or Fosc/64
1	1	Mode 3	9-bit UART	Variable (set by timer 1)

 SM2 (SCON.5): Multiprocessor communication bit. In modes 2 and 3, if set this will enable multiprocessor communication.

- REN (SCON.4) : Enable serial reception
- TB8 (SCON.3) : This is 9th bit that is transmitted in mode 2 & 3.
- RB8 (SCON.2): 9th data bit is received in modes 2 & 3.
- TI (SCON.1) : Transmit interrupt flag, set by hardware must be cleared by software.

 RI (SCON.0) : Receive interrupt flag, set by hardware must be cleared by software.

PCON register: The SMOD bit (bit 7) of PCON register controls the baud rate in asynchronous mode transmission.

	Powe	er mod	le Con	trol (PC	ON) Re	egister	
D7	D6	D5	D4	D3	D2	D1	DO
SMOD				GF1	GF0	PD	IDL

 SMD (PCON.7): Serial rate modify bit. Set to 1 by program to double baud rate using timer 1 for modes 1, 2, and 3. cleared by program to use timer 1 baud rate.

GF1 (PCON.3) : General Purpose user flag bit.

GF0 (PCON.2) : General Purpose user flag bit.

- PD (PCON.1) : Power down bit. Set to 1 by program to
- enter power down configuration for CHMOS processors.

 IDL (PCON.0) : Idle mode bit. Set to 1 by program to enter idle mode configuration for CHMOS processors.

6.1.4. SERIAL COMMUNICATION MODES

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1. Mode 0

In this mode serial port runs in synchronous mode. The data is transmitted and received through RXD pin and TXD is used for clock output. In this mode the baud rate is 1/12 of clock frequency.

2. Mode 1

In this mode SBUF becomes a 10 bit full duplex transceiver. The ten bits are 1 start bit, 8 data bit and 1 stop bit. The interrupt flag TI/RI will be set once transmission or reception is over. In this mode the baud rate is variable and is determined by the timer 1 overflow rate.

Baud rate = [2^{smod}/32] x Timer 1 overflow Rate

[2smod/32] x [Oscillator Clock Frequency] / [12 x [256 – [TH1]]]

3. Mode 2

This is similar to mode 1 except 11 bits are transmitted or received. The 11 bits are, 1 start bit, 8 data bit, a programmable 9th data bit, 1 stop bit.

Baud rate = [2smod/64] x Oscillator Clock Frequency

4. Mode 3

This is similar to mode 2 except baud rate is calculated as in mode 1

6.1.5. CONNECTIONS TO RS-232

RS-232 standards:

To allow compatibility among data communication equipment made by various manufactures, an interfacing standard called RS232 was set by the Electronics Industries Association (EIA) in 1960. Since the standard was set long before the advent of logic family, its input and output voltage levels are not TTL compatible.

In RS232, a logic one (1) is represented by -3 to -25V and referred as MARK while logic zero (0) is represented by +3 to +25V and referred as SPACE. For this reason to connect any RS232 to a microcontroller system we must use voltage converters such as MAX232 to convert the TTL logic level to RS232 voltage levels and vice-versa. MAX232 IC chips are commonly referred as line drivers.

In RS232 standard we use two types of connectors. DB9 connector or DB25 connector.



The pin description of DB9 and DB25 Connectors are as follows

DB-25 Pin No.	DB-9 Pin No.	Abbreviation	Full Name		
Pin 2	Pin 3	TD	Transmit Data		
Pin 3	Pin 2	RD	Receive Data		
Pin 4	Pin 7	RTS	Request To Send		
Pin 5	Pin 8	CTS	Clear To Send		
Pin 6	Pin 6	DSR	Data Set Ready		
Pin 7	Pin 5	SG	Signal Ground		
Pin 8	Pin 1	CD	Carrier Detect		
Pin 20	Pin 4	DTR	Data Terminal Ready		
Pin 22	Pin 9	RI	Ring Indicator		

The 8051 connection to MAX232 is as follows.

The 8051 has two pins that are used specifically for transferring and receiving data serially. These two pins are called TXD, RXD. Pin 11 of the 8051 (P3.1) assigned to TXD and pin 10 (P3.0) is designated as RXD. These pins TTL compatible; therefore they require line driver (MAX 232) to make them RS232 compatible. MAX 232 converts RS232 voltage levels to TTL voltage levels and vice versa. One advantage of the MAX232 is that it uses a +5V power source which is the same as the source voltage for the 8051. The typical connection diagram between MAX 232 and 8051 is shown below.



6.1.6. SERIAL COMMUNICATION PROGRAMMING IN ASSEMBLY AND C.

Steps to programming the 8051 to transfer data serially

- 1. The TMOD register is loaded with the value 20H, indicating the use of the Timer 1 in mode 2 (8-bit auto reload) to set the baud rate.
- The TH1 is loaded with one of the values in table 5.1 to set the baud rate for serial data transfer.
- 3. The SCON register is loaded with the value 50H, indicating serial mode 1, where an 8-bit data is framed with start and stop bits.
- 4. TR1 is set to 1 start timer 1.
- 5. TI is cleared by the "CLR TI" instruction.
- 6. The character byte to be transferred serially is written into the SBUF register.
- The TI flag bit is monitored with the use of the instruction JNB TI, target to see if the character has been transferred completely.
- 8. To transfer the next character, go to step 5.

Example 1. Write a program for the 8051 to transfer letter 'A' serially at 4800- baud rate, 8 bit data, 1 stop bit continuously.

ORG 0000H	
LJMP START	
ORG 0030H	
START: MOV TMOD, #20)H ; select timer 1 mode 2
MOV TH1, #0FAH	; load count to get baud rate of 4800
MOV SCON, #50H	; initialize UART in mode 2
	; 8 bit data and 1 stop bit
SETB TR1	; start timer
AGAIN: MOV SBUF, #'A'	; load char 'A' in SBUF
BACK: JNB TI, BACK ; C	heck for transmit interrupt flag
CLR TI ; C	lear transmit interrupt flag
SJMP AGAIN	
END	

Example 2. Write a program for the 8051 to transfer the message 'EARTH' serially at 9600 baud, 8 bit data, 1 stop bit continuously.

ORG 0000H LJMP START

ORG 0030H	
START: MOV TMOD, #20H	; select timer 1 mode 2
MOV TH1, #0FDH	; load count to get reqd. baud rate of 9600
MOV SCON, #50H	; initialise uart in mode 2
	; 8 bit data and 1 stop bit
SETB TR1	; start timer
LOOP: MOV A, #'E'	; load 1st letter 'E' in a
ACALL LOAD	; call load subroutine
MOV A, #'A'	; load 2nd letter 'A' in a
ACALL LOAD	; call load subroutine
MOV A, #'R'	; load 3rd letter 'R' in a
ACALL LOAD	; call load subroutine
MOV A, #'T'	; load 4th letter 'T' in a
ACALL LOAD	; call load subroutine
MOV A, #'H'	; load 4th letter 'H' in a
ACALL LOAD	; call load subroutine
SJMP LOOP	; repeat steps
LOAD: MOV SBUF, A	
HERE: JNB TI, HERE ; Chec	k for transmit interrupt flag
CLR TI	; Clear transmit interrupt flag
RET	

END

6.2 8255A PROGRAMMABLE PERIPHERAL INTERFACE

Introduction

The 8255A programmable peripheral interface (PPI) implements a general-purpose I/O interface to connect peripheral equipment to a microcomputer system bus.

Features

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- Three 8-bit Peripheral Ports Ports A, B, and C
- Three programming modes for Peripheral Ports: Mode 0 (Basic Input/Output), Mode 1 (Strobed Input/Output), and Mode 2 (Bidirectional)
- Total of 24 programmable I/O lines
- · 8-bit bidirectional system data bus with standard microprocessor interface controls

6.2.1. ARCHITECTURE OF 8255A



Read/Write Control Logic has six connections.

Read, Write: This control signal enables the Read/Write operation. When the signal is low, the controller reads/writes data from/to a selected I/O Port of the 8255.

RESET: This is an active high signal; it clears the control register and sets all ports in the input mode.

CS, **A0** and **A1**: Theses are device select signals. Chip Select is connected to a decoded address, and A0 and A1 are generally connected to MPU address lines A0 and A1 respectively

A	A.	Selected				
0	0	PortA				
0	1	PortB				
1	0	Port C				
1	1	Control Register				
х	x	Not Selected				
	A1 0 1 1 X	A1 A6 0 0 0 1 1 0 1 1 X X				

Control register is an 8 bit register. The contents of this register called control word. This register can be accessed to write a control word when A0 and A1 are at logic 1. This control register is not accessible for a read operation.

Bit D7 of the control register specifies either I/O function or the Bit Set/Reset function. If bit D7=1, bits D6-D0 determines I/O functions in various modes. If bit D7=0, Port C operates in the Bit Set/Reset (BSR) mode. The BSR control word does not affect the functions of Port A and Port B.





6.2.2. I/O ADDRESSING

8051 can be interfaced with the processor by two methods

- Isolated I/O, I/O mapped I/O. In this addressing method, IN,OUT instructions (microprocessors) are used to access the input/output devices.
- Memory mapped I/O. The instructions used to access the memory itself will be used for accessing I/O devices. The I/O devices are connected to the addresses where it can be accessed using simple memory accessing mechanism.

ADDITIONAL NOTES

THEORY RELATED TO ADC

ADC Devices:

Analog to digital converters are among the most widely used devices for data acquisitions. Digital computers use binary (discrete) value but in physical world everything is analog (continuous). A physical

quantity is converted to electrical signals using device called transducer or also called as sensors. Sensors and many other natural quantities produce an output that is voltage (or current). Therefore we need an

analog - to - digital converter to translate the analog signal to digital numbers so that the microcontroller can read and process them.

An ADC has an n bit resolution where n can be 8, 10, 16, 0r even 24 bits. The higher resolution ADC provides a smaller step size, where step size is smallest change that can be discerned by an ADC. This is shown below.

n - bit	Number of steps	Step Size (mV)
8	256	5/256 = 19.53
10	1024	5/1024 = 4.88
12	4096	5/4096 = 1.2
16	65536	5/65536 = 0.076

In addition to resolution, conversion time is another major factor in judging an ADC. Conversion time is defined as the time it takes the ADC to convert the analog input to digital (binary) number. The ADC chips are either parallel or serial. In parallel ADC, we have 8 or more pins dedicated to bring out the binary data, but in serial ADC we have only one pin for data out.

ADC 0808



ADC0808, has 8 analog inputs. ADC0808 allows us to monitor up to 8 different analog inputs using only a single chip. ADC0808 has an 8-bit data output. The 8 analog inputs channels are multiplexed and selected according to table given below using three address pins, A, B, and C.

Select Analog Channel	С	B	A	
INO	0	0	0	
IN1	0	0	1	
IN2	0	1	0	
IN3	0	1	1	
IN4	1	0	0	
IN5	1	0	1	
IN6	1	1	0	
IN7	1	1	1	

In ADC0808 Vref (+) and Vref (-) set the reference voltage. If Vref (-) = Gnd and Vref (+) = 5V, the step size is 5V/256 = 19.53 mV. Therefore,to get a 10 mV step size we need to set Vref (+) = 2.56V and Vref(-) = Gnd. ALE is used to latch in the address. SC for start conversion. EOC is for end-of-conversion, and OE is for output enable (READ). Table shows the step size relation to the Vref Voltage.

V _{ref} (v)	V _{in} (V)	Step Size (mV)					
Not connected	0 to 5	5/256 = 19.53					
4.0	0 to 4	4/256 = 15.32					
3.0	0 to 3	3/256 = 11.71					
2.56	0 to 2.56	2.56/256 = 10					
2.0	0 to 2	2/256 = 7.81					
1	0 to 1	1/256 = 3.90					

Steps to access data from ADC0808

- 1. Select an analog channel by providing bits to A, B, and C addresses according to table.
- 2. Activate the ALE (address latch enable) pin. It needs an L-to-H pulse to latch in the address.
- 3. Activate SC (start conversion) by an L-to-H pulse to initiate conversion.
- 4. Monitor EOC (end of conversion) to see whether conversion is finished. H-to-l output indicates that data is converted and ready to be picked up.
- Activate OE (output enable) to read data out of ADC chip. An L-to-H pulse to the OE pin will bring digital data out of the chip. Also notice that the OE is the same as the RD pin in other ADC chip.
- 6. Notice that in ADC0808 there is no self-clocking and the clock must be provided from an external source to the CLK pin. Although the speed of conversion depends on the frequency of the clock connected to the CLK pin, it cannot be faster than 100 microseconds.

UNIT 7: Motivation for MSP430microcontrollers

- Low Power embedded systems, On-chip peripherals (analog and digital), low-power RF capabilities. Target applications (Single-chip, low cost, low power, high performance system design). 2 Hrs

MSP430 RISC CPU architecture, Compiler-friendly features, Instruction set, Clock system, Memory subsystem. Key differentiating factors between different MSP430 families. 2 Hrs.

Introduction to Code Composer Studio (CCS v4). Understanding how to use CCS for Assembly, C, Assembly+C projects for MSP430 microcontrollers. Interrupt programming. 3 Hrs Digital 1/0 – 1/0 ports programming using C and assembly, Understanding the muxing scheme of the MSP430 pins. 2 Hrs

UNIT 8: On-chip peripherals. Watchdog Timer,

Comparator, Op-Amp, Basic Timer, Real Time Clock (RTC), ADC, DAC, SD16, LCD, DMA. 2 Hrs

Using Low-power features of MSP430. Clock system, low-power modes, Clock request feature, Lowpower programming and Interrupt. 2 Hrs

Interfacing LED, LCD, External memory. Seven segment LED modules interfacing. Example – Realtime clock. 2 Hrs

Case Studies of applications of MSP430 - Data acquisition system, Wired Sensor network, Wireless sensor network with Chipcon RF interfaces. 3 Hrs

LOW POWER EMBEDDED SYSTEMS

1. EMBEDDED SYSTEM DESIGN CYCLE

Market requirements > Functional Specification> Architecture > Component Design > System Integration > Testing

2. NEED FOR LOW-POWER EMBEDDED SYSTEMS

- a. Why Low-Power is important
 - Longer battery life
 - Smaller products
 - Simpler power supplies
 - Less EMI simplifies PCB
 - Permanent battery
 - Environmental Stewardship

b. Examples of low power applications

- RFID based forest monitoring
- Structural monitoring
- Wildlife habitat monitoring

3. POWER AWARE ARCHITECTURE

a. Sources of power consumption

- o Dynamic power: Charging and discharging of capacitors and on switching activity
- Short circuit power
- o Leakage leaking diodes and transistors
- b. Trade-off between power and speed.
 - Power consumption of CMOS circuits (ignoring leakage), P = α C_LV²_{dd} f, Where, α = parameter on switching activity, C = load capacitance, V_{dd} = supply voltage, f = frequency
 - Decreasing voltage reduces power consumption(quadratically)
 - Higher supply voltages reduce delay but increase power consumption (due to quadratic relation)
- c. Power saving techniques

- o Trade-off performance to save power
 - Reduce power supply voltage
 Reduce frequency
- o Structural power saving techniques

 - Disable peripheral when not in use (E.g. Clock Gating)
 Disconnect modules from power supply when not in use (E.g. Power Gating)

 - Clock gating Deactivate clocks to unused registers
 Signal gating Deactivate signals that cause activity if not in use
 Power gating Deactivate Vdd for unused HW blocks

Pin diagram of the MSP430F2003 and F2013



- VCC and VSS are the supply voltage and ground for the whole device (the analog and digital supplies are separate in the 16-pin package).
- 5. P1.0-P1.7, P2.6, and P2.7 are for digital input and output, grouped into ports P1 and P2.
- TACLK, TA0, and TA1 are associated with Timer_A; TACLK can be used as the clock input to the timer, while TA0 and TA1 can be either inputs or outputs. These can be used on several pins because of the importance of the timer.
- A0-, A0+, and so on, up to A4±, are inputs to the analog-to-digital converter. It has four differential channels, each of which has negative and positive inputs. VREF is the reference voltage for the converter.
- ACLK and SMCLK are outputs for the microcontroller's clock signals. These can be used to supply a clock to external components or for diagnostic purposes.
- SCLK, SDO, and SCL are used for the universal serial interface, which communicates with external devices using the serial peripheral interface (SPI) or inter-integrated circuit (I2C) bus.
- XIN and XOUT are the connections for a crystal, which can be used to provide an accurate, stable clock frequency.
- RST is an active low reset signal. Active low means that it remains high near VCC for normal operation and is brought low near VSS to reset the chip. Alternative notations to show the active low nature are _RST and /RST.
- NMI is the non-maskable interrupt input, which allows an external signal to interrupt the normal
 operation of the program.
- TCK, TMS, TCLK, TDI, TDO, and TEST form the full JTAG interface, used to program and debug the device.
- SBWTDIO and SBWTCK provide the Spy-Bi-Wire interface, an alternative to the usual JTAG connection that saves pins.

Architecture of MSP 430

Block diagram of the MSP430F2003 and F2013, taken from data sheet.

The main features of the MSP RISC CPU architecture are,

- On the left is the CPU and its supporting hardware, including the clock generator. The emulation, JTAG interface and Spy-Bi-Wire are used to communicate with a desktop computer when downloading a program and for debugging
- Clock generator generates up to three different clocks (MCLK, ACLK & SMCLK) using four different sources (VCO, DCO, LFXT1 and XT2).
- 3. The main blocks are linked by the memory address bus (MAB) and memory data bus (MDB).
- 4. These devices have flash memory, 1KB in the F2003 or 2KB in the F2013, and 128 bytes of RAM.
- 5. Six blocks are shown for peripheral functions (there are many more in larger devices).
 - a. Input/output ports,
 - b. Timer_A,
 - c. Watchdog timer (resets the processor if program becomes stuck in the infinite loop).
 - d. The universal serial interface (USI) (SPI, I²C, RS232, USB, CAN etc...)
 - e. Sigma-delta analog-to-digital converter (SD16_A)



- 6. The brownout protection comes into action if the supply voltage drops to a dangerous level. Most devices include this but not some of the MSP430x1xx family.
- There are ground and power supply connections. Ground is labeled VSS and is taken to define 0V. The supply connection is VCC which is mostly in the range of 1.8–3.6V.

REGISTERS OF MSP 430

MSP 430 has sixteen 16-bit registers. These registers do not have address in the main memory map. First four registers have dedicated alternate functions and the remaining 12 registers are used as working registers for general purposes.

R0/PC (PROGRAM COUNTER)
R1/SP (STACK POINTER)
R2/SR (STATUS REGISTER)
R3/CG (CONSTANT GENERATOR)
R4 (GENERAL PURPOSE)
R5 (GENERAL PURPOSE)
R6 (GENERAL PURPOSE)
R7 (GENERAL PURPOSE)

R8 (GENERAL PURPOSE)
R9 (GENERAL PURPOSE)
R10 (GENERAL PURPOSE)
R11 (GENERAL PURPOSE)
R12 (GENERAL PURPOSE)
R13 (GENERAL PURPOSE)
R14 (GENERAL PURPOSE)
R15 (GENERAL PURPOSE)

Program counter, PC: This contains the address of the next instruction to be executed

Stack pointer, SP: MSP430 uses the top (high addresses) of the main RAM as stack memory. The stack pointer holds the address of the most recently added word and is automatically adjusted as the stack grows downward in memory or shrinks upward.

Status register, SR: This contains a set of flags (single bits), whose functions fall into three categories. The most commonly used flags are C, Z, N, and V, which give information about the result of the last arithmetic or logical operation. The Z flag is set if the result was zero and cleared if it was nonzero, for instance. Setting the GIE bit enables maskable interrupts. The final group of bits is CPUOFF, OSCOFF, SCGO, and SCG1, which control the mode of operation of the MCU. All systems are active when all bits are clear.

Constant generator: This provides the six most frequently used values so that they need not be fetched from memory whenever they are needed. It uses both R2 and R3 to provide a range of useful values by exploiting the CPU's addressing modes.

General purpose registers: The remaining 12 registers, R4–R15, are general working registers. They may be used for either data or addresses because both are 16-bit values, which simplify the operation significantly.

COMPILER FRIENDLY FEATURES

MSP430 stems from its recent introduction is that it is designed with compilers in mind. Most small microcontrollers are now programmed in C, and it is important that a compiler can produce compact, efficient code. The MSP430 has 16 registers in its CPU, which enhances efficiency because they can be used for local variables, parameters passed to subroutines, and either addresses or data. This is a typical feature of a RISC, but unlike a "pure" RISC, it can perform arithmetic directly on values in main memory. Microcontrollers typically spend much of their time on such operations.



MEMORY ADDRESS SPACE

- The MSP430 von Neumann architecture has one address space shared with
 - special function registers (SFRs),
 - o peripherals,
 - o RAM, and
 - Flash/ROM memory
- Code access are always performed on even addresses.

- Data can be accessed as bytes or words.
- The addressable memory space is 64 KB

Flash/ROM

- · The start address depends on the amount of Flash/ROM present and varies by device.
- The end address is 0FFFFh for devices with less than 60kB of Flash/ROM; otherwise, it is device dependent.
- Flash can be used for both code and data.
- Word or byte tables can be stored and used without the need to copy the tables to RAM before using them.
- The interrupt vector table is mapped into the upper 16 words of address space, with the highest priority interrupt vector at address (0FFFEh).

RAM

- RAM starts at 0200h.
- End address depends on the amount of RAM present and varies by device.
- RAM can be used for both code and data.

Peripheral Modules

- 0100 to 01FFh is reserved for 16-bit peripheral modules.
- Accessed with word instructions.
- If Byte instructions are used ,then high byte of the result is always 0.
- 010h to 0FFh is reserved for 8-bit peripheral modules.
- These modules should be accessed with byte instructions.
- · Accessed using word instructions results in unpredictable data in the high byte.
- If word data is written to a byte module only the low byte is written into the peripheral register, ignoring the high byte.

SFRs

- Peripheral functions are configured in the SFRs.
- Located in the lower 16 bytes of the address space and are organized by byte.
- SFRs must be accessed using byte instructions only

ADDRESSING MODES

- 1. Register addressing mode. The address is formed by adding a constant base address to the contents of a CPU register; the value in the register is not changed.
 - Eg: MOV R10, R11

Length: One or two words

Operation: Move the content of R10 to R11. R10 is not affected.

Before:	After:							
R10 - 0A023h	R10 - 0A023h							
R11 - 0FA15h	R11 - 0A023h							
PC - PC old	PC - PC old + 2							

2. Indexed addressing mode. In this case the program counter PC is used as the base address, so the constant is the offset to the data from the PC.

Eg: MOV 2(R5),6(R6)

Length: 2 or 3 words

Operation: Move the contents of the source address (contents of R5 + 2) to the destination address (contents of R6 + 6).

3. Symbolic Mode (PC Relative)

In this case the program counter PC is used as the base address, so the constant is the offset to the data from the PC

Eg: MOV EDE, TONI

Length: Two or three words

Operation: Move the contents of the source address EDE (contents of PC + X) to the destination address TONI (contents of PC + Y).

4. Absolute Mode: The constant in this form of indexed addressing is the absolute address of the data. This is already the complete address required so it should be added to a register that contains 0. Absolute addressing is shown by the prefix & and should be used for special function and peripheral registers, whose addresses are fixed in the memory map.

Eg: mov.b &P1IN ,R6; copies the port 1 input register into register R6

5. Indirect Register Mode:

Eg: MOV @R10,0(R11)

Operation: Move the contents of the source whose address is in (R10) to the destination address (R11). Indirect addressing cannot be used for the destination.

6. Indirect Auto increment Mode: This is available only for the source and is shown by the symbol @ in front of a register with a + sign after it, such as @R5+. It uses the value in R5 as a pointer and automatically increments it afterward by 1 if a byte has been fetched or by 2 for a word. Eg: MOV @R10+,0(R11)

7. Immediate Mode

Eg: MOV #45h,TONI: Operation: Move the immediate constant 45h, which is contained in the word following the instruction, to destination address TONI. When fetching the source, the program counter points to the word following the instruction and moves the contents to the destination.

CLOCK SYSTEM

Figure below shows a simplified diagram of the Basic Clock Module+ (BCM+) for the MSP430F2xx family. The clock module provides three outputs:

- Master clock, MCLK is used by the CPU and a few peripherals.
- Sub-system master clock, SMCLK is distributed to peripherals.
- Auxiliary clock, ACLK is also distributed to peripherals.

Most peripherals can choose either SMCLK, which is often the same as MCLK and in the megahertz range, or ACLK, which is typically much slower and usually 32 KHz. A few peripherals, such as analog-to-digital converters, can also use MCLK and some, such as timers, have their own clock inputs. The frequencies of all three clocks can be divided in the BCM+ as shown in figure.



Up to four sources are available for the clock, depending on the family and variant:

Low- or high-frequency crystal oscillator, LFXT1: Available in all devices. It is usually used with a low-frequency crystal (32 KHz) but can also run with a high-frequency crystal (typically a few MHz) in most devices. An external clock signal can be used instead of a crystal if it is important to synchronize the MSP430 with other devices in the system.

High-frequency crystal oscillator, XT2: Similar to LFXT1 except that it is restricted to high frequencies. It is available in only a few devices and LFXT1 (or VLO) is used instead if XT2 is missing. **Internal very low-power, low-frequency oscillator, VLO:** Available in only the more recent MSP430F2xx devices. It provides an alternative to LFXT1 when the accuracy of a crystal is not needed.

Digitally controlled oscillator, DCO: Available in all devices and one of the highlights of the MSP430. It is basically a highly controllable RC oscillator that starts in less than 1µs in newer devices.

WATCH DOG TIMERS.

The main purpose of the watchdog timer is to protect the system against failure of the software, such as the program becoming trapped in an unintended, infinite loop. Watchdog counts up and resets the MSP430 when it reaches its limit. The code must therefore keep clearing the counter before the limit is reached to prevent a reset. The operation of the watchdog is controlled by the 16-bit register WDTCTL



The watchdog counter is a 16-bit register WDTCNT, which is not visible to the user. It is clocked from either SMCLK (default) or ACLK, according to the WDTSSEL bit. The watchdog is always active after the MSP430 has been reset. By default the clock is SMCLK, which is in turn derived from the DCO at about 1 MHz. The default period of the watchdog is the maximum value of 32,768 counts, which is therefore around 32 ms. We must clear, stop, or reconfigure the watchdog before this time has elapsed. If the watchdog is left running, the counter must be repeatedly cleared to prevent it counting up as far as its limit. This is done by setting the WDTCNTCL bit in WDTCTL. The watchdog timer sets the WDTIFG flag in the special function register IFG1. This is cleared by a power-on reset but its value is preserved during a PUC. Thus a program can check this bit to find out whether a reset arose from the watchdog.

BASIC TIMER.

Basic Timer1 is present in all MSP430xF4xx devices. It provides the clock for the LCD module and generates periodic interrupts. A simplified block diagram of basic timer is shown in figure below. Newer devices contain a real-time clock driven by a signal at 1Hz from Basic Timer1. The register BTCTL controls most of the functions of Basic Timer1 but there are also bits in the special function registers IFG2 and IE2 for interrupts.



The Basic Timer1 control register BTCTL.

REAL TIME CLOCK.

ADC10 SAR PERIPHERAL MODULE

Figure below shows a simplified block diagram of the ADC10 in the F20x2; there are more inputs in larger devices.



The ADC10 module of the MSP430F2274 supports fast 10 bit analogue-to-digital conversions; The module contains:

- 10-bit SAR core; The ADC100N bit enables the core and a flag ADC10BUSY is set while sampling and conversion is in progress. The result is written to ADC10MEM in a choice of two formats, selected with the ADC10DF bit.
- Clock; This can be taken from MCLK, SMCLK, ACLK, or the module's internal oscillator ADC100SC, selected with the ADC10SSELx bits.
- Sample-and-Hold Unit: This is shown separately in the block diagram. The time is chosen with the ADC10SHTx bits, which allow 4, 8, 16, or 64 cycles of ADC10CLK.
- Input Selection: A multiplexer selects the input from eight external pins A0–A7 (more in larger MSP430s) and four internal connections.
- Conversion Trigger; A conversion can be triggered in two ways provided that the ENC bit is set. The first is by setting the ADC10SC bit from software (it clears again automatically).

DIGITAL I/O PORTS

There are 10 to 80 input/output pins on different devices in the current portfolio of MSP430s; the F20xx has one complete 8-pin port and 2 pins on a second port, while the largest devices have ten full ports. Almost all pins can be used either for digital input/output or for other functions and their operation must be configured when the device starts up. Up to eight registers are associated with the digital input/output functions for each pin. Here are the registers for port P1 on a MSP430F2xx, which has the maximum number. Each pin can be configured and controlled individually; thus some pins can be digital inputs, some outputs, some used for analog functions, and so on.

- Port P1 input, P1IN: reading returns the logical values on the inputs if they are configured for digital input/output. This register is read-only and volatile. It does not need to be initialized because its contents are determined by the external signals.
- Port P1 output, P10UT: writing sends the value to be driven to each pin if it is configured as a digital output. If the pin is not currently an output, the value is stored in a buffer and appears on the pin if it is later switched to be an output. This register is not initialized and you should therefore write to P10UT before configuring the pin for output.
- Port P1 direction, P1DIR: clearing a bit to 0 configures a pin as an input, which is the default in most cases. Writing a 1 switches the pin to become an output. This is for digital input and output; the register works differently if other functions are selected using P1SEL.
- Port P1 resistor enable, P1REN: setting a bit to 1 activates a pull-up or pull-down resistor on a pin. Pull-ups are often used to connect a switch to an input as in the section "Read Input from a Switch" on page 80. The resistors are inactive by default (0). When the resistor is enabled (1), the corresponding bit of the P10UT register selects whether the resistor pulls the input up to VCC (1) or down to VSS (0).
- Port P1 selection, P1SEL: selects either digital input/output (0, default) or an alternative function (1). Further registers may be needed to choose the particular function.
- Port P1 interrupt enable, P1IE: enables interrupts when the value on an input pin changes. This feature is activated by setting appropriate bits of P1IE to 1. Interrupts are off (0) by default. The whole port shares a single interrupt vector although pins can be enabled individually.
- Port P1 interrupt edge select, P1IES: can generate interrupts either on a positive edge (0), when the input goes from low to high, or on a negative edge from high to low (1). It is not possible to select interrupts on both edges simultaneously but this is not a problem because the direction can be reversed after each transition. Care is needed if the direction is changed while interrupts are enabled because a spurious interrupt may be generated. This register is not initialized and should therefore be set up before interrupts are enabled.
- Port P1 interrupt flag, P1IFG: a bit is set when the selected transition has been detected on the input. In addition, an interrupt is requested if it has been enabled. These bits can also be set by software, which provides a mechanism for generating a software interrupt (SWI).

Additional Questions:

- 1. Explain the following instructions.
 - a) DADD: DECIMAL ADD source and carry to the destination.

(Destination) = (carry) + (source) + (destination)

- b) BIC: BIC(.b or .w) src, dst: not src and dst to dst.
- c) CMP: CMP(.b or .w) src, dst: compare source and destination.
- d) SXT dst. Extend bit 7 to bit 8-bit15 (sign extended destination.)
- e) CALL (.b or .w) dst: SP-2 > SP, PC+2 > @SP, dst > PC (subroutine call to destination)

Missing 8255 Notes

Eg: interface 8255A with 8051 microcontroller such that the control register is selected for the address 1003H. find the address of port A,B and C Solution

The control register is selected for the address 1003H. Address lines A15 to A0 for ports and control register is as follows.

A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0	
0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	PORT A
0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	1	PORT B
0	0	0	1	0	0	0	0	0	0	0	0	0	0	1	0	PORT C
0	0	0	1	0	0	0	0	0	0	0	0	0	0	1	1	CR

Address of Port A is 1000h, Port B is 1001h, port C is 1002h and control word is 1003h. RD and WR pins of 8051 is connected to RD and WR pins of 8255 as shown in fig. A0 and A1 from 8255 are directly connected to address lines of 8051. Remaining address lines are connected to the decoder 74LS138 and the output of the decoder is connected to the CS pin of 8255. Data pins of 8255 is directly connected to the data bus of 8051 microcontroller.